



# EM120R-GL&EM160R-GL

## Hardware Design

**LTE-A Module Series**

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Our aim is to provide customers with timely and comprehensive service. For any assistance, please contact our company headquarters:

**Quectel Wireless Solutions Co., Ltd.**

Building 5, Shanghai Business Park Phase III (Area B), No.1016 Tianlin Road, Minhang District,  
Shanghai 200233, China  
Tel: +86 21 5108 6236  
Email: [info@quectel.com](mailto:info@quectel.com)

**Or our local office. For more information, please visit:**

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## About the Document

### Revision History

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# 1 Introduction

This document defines EM120R-GL&EM160R-GL and describes its air interfaces and hardware interfaces which are connected to customers' applications.

This document is applicable to the following modules:

- EM120R-GL
- EM160R-GL

This document can help customers quickly understand the interface specifications, electrical and mechanical details, as well as other related information of EM120R-GL&EM160R-GL. To facilitate its application in different fields, reference design is also provided for customers' reference. This document, coupled with application notes and user guides, can help customers use the module to design and set up mobile applications easily.

## 1.1. Safety Information

The following safety precautions must be observed during all phases of operation, such as usage, service or repair of any cellular terminal or mobile incorporating EM120R-GL&EM160R-GL modules. Manufacturers of the cellular terminal should notify users and operating personnel of the following safety information by incorporating these guidelines into all manuals of the product. Otherwise, Quectel assumes no liability for customers' failure to comply with these precautions.



Full attention must be paid to driving at all times in order to reduce the risk of an accident. Using a mobile while driving (even with a handsfree kit) causes distraction and can lead to an accident. Please comply with laws and regulations restricting the use of wireless devices while driving.



Switch off the cellular terminal or mobile before boarding an aircraft. The operation of wireless appliances in an aircraft is forbidden to prevent interference with communication systems. If there is an Airplane Mode, it should be enabled prior to boarding an aircraft. Please consult the airline staff for more restrictions on the use of wireless devices on an aircraft.



Wireless devices may cause interference on sensitive medical equipment, so please be aware of the restrictions on the use of wireless devices when in hospitals, clinics or other healthcare facilities.



Cellular terminals or mobiles operating over radio signals and cellular network cannot be guaranteed to connect in all possible conditions (for example, with unpaid bills or with an invalid (U)SIM card). When emergent help is needed in such conditions, use emergency call. In order to make or receive a call, the cellular terminal or mobile must be switched on in a service area with adequate cellular signal strength.



The cellular terminal or mobile contains a transmitter and receiver. When it is ON, it receives and transmits radio frequency signals. RF interference can occur if it is used close to TV set, radio, computer or other electric equipment.



In locations with potentially explosive atmospheres, obey all posted signs to turn off wireless devices such as mobile phone or other cellular terminals. Areas with potentially explosive atmospheres include fueling areas, below decks on boats, fuel or chemical transfer or storage facilities, areas where the air contains chemicals or particles such as grain, dust or metal powders.

## 2 Product Concept

### 2.1. General Description

EM120R-GL&EM160R-GL are LTE-A/UMTS/HSPA+ wireless communication modules with receive diversity. It provides data connectivity on LTE-FDD, LTE-TDD, DC-HSDPA, HSPA+, HSDPA, HSUPA and WCDMA networks with standard PCI Express M.2 interface.

It supports embedded operating systems such as Windows, Linux and Android, and provides GNSS <sup>1)</sup> and voice functionality <sup>2)</sup> to meet customers' specific application demands.

The following table shows the frequency bands and GNSS types of EM120R-GL&EM160R-GL.

**Table 1: Frequency Bands and GNSS Types of EM120R-GL&EM160R-GL**

| Mode                                               | EM120R-GL&EM160R-GL                                                                                                                                                                                                                                     |
|----------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| LTE-FDD<br>(with Rx-diversity/MIMO <sup>5)</sup> ) | B1 <sup>4)</sup> /B2 <sup>4)</sup> /B3 <sup>4)</sup> /B4 <sup>4)</sup> /B5/B7 <sup>4)</sup> /<br>B8/B12/B13/B14/B17/B18/B19/B20/B25 <sup>4)</sup> /B26/B28/<br>B29 <sup>3)</sup> /B30 <sup>4)</sup> /B32 <sup>3)</sup> <sup>4)</sup> /B66 <sup>4)</sup> |
| LTE-TDD<br>(with Rx-diversity/MIMO <sup>5)</sup> ) | B38 <sup>4)</sup> /B39 <sup>4)</sup> /B40 <sup>4)</sup> /B41 <sup>4)</sup> /B42/B43/B46 <sup>3)</sup> /B48                                                                                                                                              |
| WCDMA<br>(with Rx-diversity)                       | B1/B2/B3/B4/B5/B6/B8/B19                                                                                                                                                                                                                                |
| GNSS <sup>1)</sup>                                 | GPS;<br>GLONASS;<br>BeiDou/Compass;<br>Galileo                                                                                                                                                                                                          |

#### NOTES

- <sup>1)</sup> GNSS function is optional.
- <sup>2)</sup> EM120R-GL&EM160R-GL contain **Telematics** version and **Data-only** version. **Telematics** version supports voice and data functions, while **Data-only** version only supports data function.
- <sup>3)</sup> LTE-FDD B29/B32 and LTE-TDD B46 support Rx only and are only for secondary component

carrier.

4. <sup>4)</sup> EM160R-GL supports up to 4 × 4 MIMO in DL direction.
5. <sup>5)</sup> MIMO antennas only apply for EM160R-GL.
6. For details about CA combinations, refer to **document [1]**.

EM120R-GL&EM160R-GL can be applied in the following fields:

- Tablet PC and Laptop
- Remote Monitor System
- Vehicle System
- Wireless POS System
- Smart Metering System
- Wireless Router and Switch
- Other Wireless Terminal Devices

## 2.2. Key Features

The following table describes the detailed features of EM120R-GL&EM160R-GL.

**Table 2: Key Features of EM120R-GL&EM160R-GL**

| Feature            | Details                                                                                                                                                                                                                                                                                                                                  |
|--------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Function Interface | PCI Express M.2 Interface                                                                                                                                                                                                                                                                                                                |
| Power Supply       | Supply voltage: 3.135–4.4 V<br>Typical supply voltage: 3.7 V                                                                                                                                                                                                                                                                             |
| Transmitting Power | Class 3 (23 dBm ±2 dB) for LTE-FDD bands<br>Class 3 (23 dBm ±2 dB) for LTE-TDD bands<br>Class 3 (24 dBm +1/-3 dB) for WCDMA                                                                                                                                                                                                              |
| LTE Features       | <b>EM160R-GL</b><br>Support up to LTE Cat 16<br>Support 1.4–100 MHz (5×CA) RF bandwidth<br>Support 4 × 4 MIMO in DL direction<br>Up to 1000 Mbps (DL)/150 Mbps (UL)<br><b>EM120R-GL</b><br>Support up to LTE Cat 12<br>Support 1.4–60 MHz (3×CA) RF bandwidth<br>Support 2 × 2 MIMO in DL direction<br>Up to 600 Mbps (DL)/150 Mbps (UL) |

|                            |                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|----------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| UMTS Features              | <p>Support 3GPP R9 DC-HSDPA, HSPA+, HSDPA, HSUPA and WCDMA</p> <p>Support QPSK, 16QAM and 64QAM modulation</p> <ul style="list-style-type: none"> <li>● DC-HSDPA: Max 42 Mbps (DL)</li> <li>● HSUPA: Max 5.76 Mbps (UL)</li> <li>● WCDMA: Max 384 Kbps (DL)/384 Kbps (UL)</li> </ul>                                                                                                                                                                                          |
| Internet Protocol Features | <ul style="list-style-type: none"> <li>● Support PPP/QMI/NTP*/TCP*/UDP*/FTP*/HTTP*/PING*/HTTPS*/SMTP*/MMS*/FTPS*/SMTPS*/SSL* protocols</li> <li>● Support the protocols PAP (Password Authentication Protocol) and CHAP (Challenge Handshake Authentication Protocol) usually used for PPP connections</li> </ul>                                                                                                                                                             |
| SMS                        | <p>Text and PDU mode</p> <p>Point to point MO and MT</p> <p>SMS cell broadcast</p> <p>SMS storage: ME by default</p>                                                                                                                                                                                                                                                                                                                                                          |
| (U)SIM Interfaces          | <p>Support (U)SIM card: 1.8/3.0 V</p> <p>Support Dual SIM Single Standby*</p>                                                                                                                                                                                                                                                                                                                                                                                                 |
| USB Interface              | <ul style="list-style-type: none"> <li>● Compliant with USB 3.0 and 2.0 specifications, with maximum transmission rates up to 5 Gbps on USB 3.0 and 480 Mbps on USB 2.0.</li> <li>● Used for AT command communication, data transmission, firmware upgrade, software debugging, GNSS NMEA sentences output and voice over USB*</li> <li>● Support USB serial drivers for:<br/>Windows: 7/8/8.1/10<br/>Linux: 2.6/3.x/4.1–4.15<br/>Android: 4.x/5.x/6.x/7.x/8.x/9.x</li> </ul> |
| PCIe x1 Interface          | <p>Comply with <i>PCI Express Specification, Revision 2.1</i> and support 5 Gbps per lane</p> <p>Used for AT command communication, data transmission, firmware upgrade, software debugging, GNSS NMEA sentences output</p>                                                                                                                                                                                                                                                   |
| Antenna connectors         | <p><b>EM160R-GL</b><br/>Provide Main, Rx-diversity/GNSS, MIMO1 and MIMO2 antenna connectors</p> <p><b>EM120R-GL</b><br/>Provide Main and Rx-diversity/GNSS antenna connectors</p>                                                                                                                                                                                                                                                                                             |
| Rx-diversity               | Support LTE/WCDMA Rx-diversity                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| GNSS Features              | <p>Gen9 Lite of Qualcomm</p> <p>Protocol: NMEA-0183</p>                                                                                                                                                                                                                                                                                                                                                                                                                       |
| AT Commands                | Compliant with 3GPP TS 27.007, 27.005 and Quectel enhanced AT commands                                                                                                                                                                                                                                                                                                                                                                                                        |
| Physical Characteristics   | <p>Size: 42.0 ±0.15 mm × 30.0 ±0.15 mm × 2.3 ±0.1 mm</p> <p>Weight: approx. 6 g</p>                                                                                                                                                                                                                                                                                                                                                                                           |
| Temperature Range          | Operation temperature range: -25 °C to +75 °C <sup>1)</sup>                                                                                                                                                                                                                                                                                                                                                                                                                   |

|                  |                                                                                                           |
|------------------|-----------------------------------------------------------------------------------------------------------|
|                  | Extended temperature range: -40 °C to +85 °C <sup>2)</sup><br>Storage temperature range: -40 °C to +90 °C |
| Firmware Upgrade | USB 2.0 interface, PCIe interface and DFOTA                                                               |
| RoHS             | All hardware components are fully compliant with EU RoHS directive                                        |

## NOTES

- <sup>1)</sup> Within operating temperature range, the module is 3GPP compliant. For those end devices with bad thermal dissipation condition, a thermal pad or other thermal conductive components may be required between the module and main PCB to achieve the full operating temperature range.
- <sup>2)</sup> Within extended temperature range, the module remains the ability to establish and maintain a voice, SMS, data transmission, emergency call, etc. There is no unrecoverable malfunction. There are also no effects on radio spectrum and no harm to radio network. Only one or more parameters like P<sub>out</sub> might reduce in their values and exceed the specified tolerances. When the temperature returns to normal operating temperature level, the module will meet 3GPP specifications again.
- "\*\*" means under development.

## 2.3. Functional Diagram

The following figure shows a block diagram of EM120R-GL&EM160R-GL.

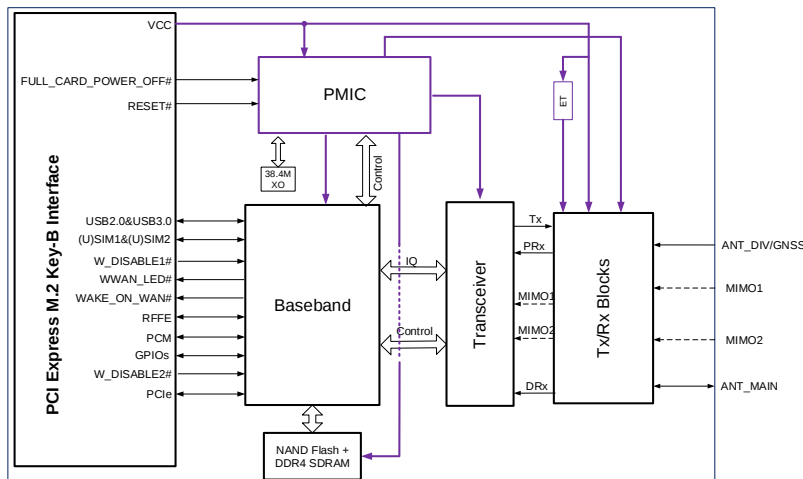


Figure 1: Functional Diagram

**NOTE**

MIMO1 and MIMO2 antennas are only applicable to the EM160R-GL module.

## 2.4. Evaluation Board

To help customers develop applications conveniently with EM120R-GL&EM160R-GL, Quectel supplies the evaluation board (M.2 EVB), USB to RS-232 converter cable, USB type-C cable, earphone, antenna and other peripherals to control or test the module. For more details, refer to **document [2]**.

## 3 Application Interfaces

The physical connections and signal levels of EM120R-GL&EM160R-GL comply with PCI Express M.2 specifications. This chapter mainly describes the definition and application of the following interfaces/signals/pins of EM120R-GL&EM160R-GL:

- Power supply
- (U)SIM interfaces
- USB interface
- PCM interface\*
- PCIe interface
- Control and indicator signals\*
- Antenna tuner control interfaces\*
- Configuration pins
- COEX UART Interface\*

### NOTE

“\*” means under development.

### 3.1. Pin Assignment

The following figure shows the pin assignment of EM120R-GL&EM160R-GL. The top side contains EM120R-GL&EM160R-GL and antenna connectors.

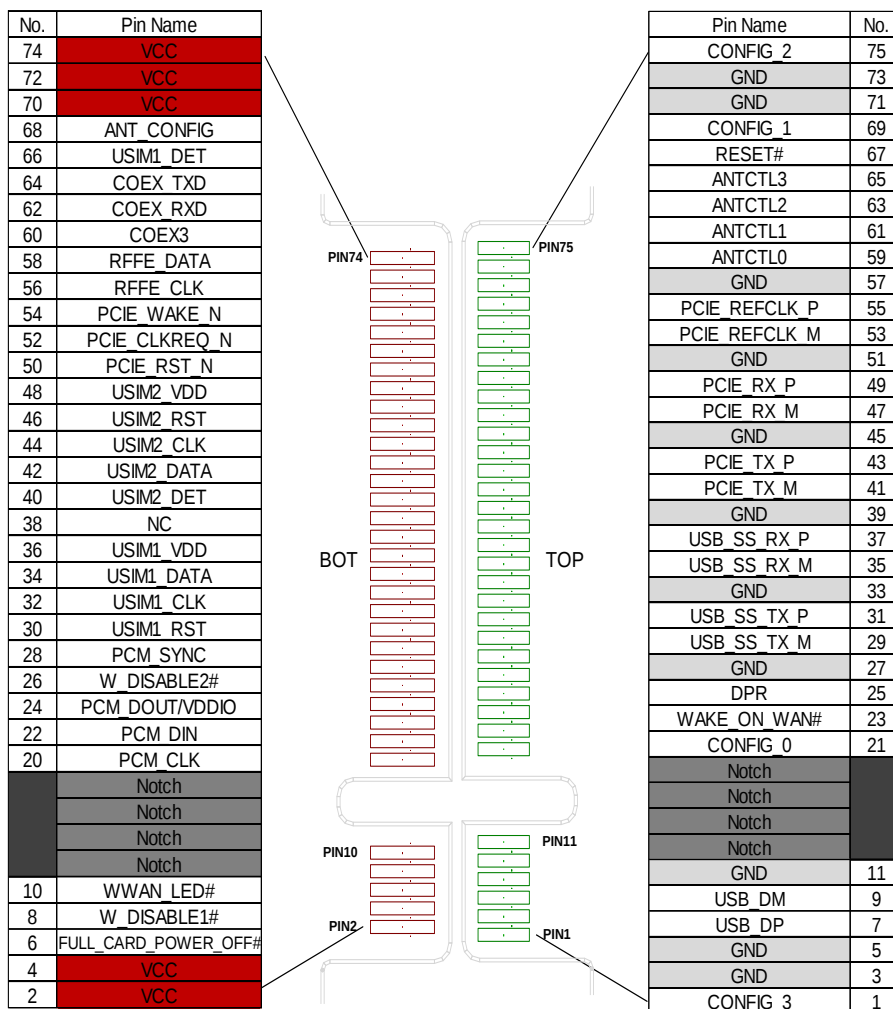


Figure 2: Pin Assignment

## 3.2. Pin Description

The following tables show the pin definition and description of EM120R-GL&EM160R-GL.

**Table 2: Definition of I/O Parameters**

| Type | Description    |
|------|----------------|
| AI   | Analog Input   |
| AO   | Analog Output  |
| DI   | Digital Input  |
| DO   | Digital Output |
| IO   | Bidirectional  |
| OD   | Open Drain     |
| PI   | Power Input    |
| PO   | Power Output   |

**Table 3: Pin Description**

| Pin No. | M.2 Socket 2 WWAN Module Pinout  | EM120R-GL&EM160R-GL Pin Name | I/O | Description                                                            | Comment                                         |
|---------|----------------------------------|------------------------------|-----|------------------------------------------------------------------------|-------------------------------------------------|
| 1       | CONFIG_3                         | CONFIG_3                     |     | NC                                                                     |                                                 |
| 2       | 3.3V                             | VCC                          | PI  | Power supply                                                           | Vmin = 3.135 V<br>Vnorm = 3.7 V<br>Vmax = 4.4 V |
| 3       | GND                              | GND                          |     | Ground                                                                 |                                                 |
| 4       | 3.3V                             | VCC                          | PI  | Power supply                                                           | Vmin = 3.135 V<br>Vnorm = 3.7 V<br>Vmax = 4.4 V |
| 5       | GND                              | GND                          |     | Ground                                                                 |                                                 |
| 6       | FULL_CARD_POWER_OFF#(I) (0/1.8V) | FULL_CARD_POWER_OFF#         | DI  | Turn on/off the module. When it is at low level, the module is powered | Pulled down internally.                         |

|    |                      |                    |           |                                                                                                               |                                                       |
|----|----------------------|--------------------|-----------|---------------------------------------------------------------------------------------------------------------|-------------------------------------------------------|
|    |                      |                    |           | off.<br>When it is at high level,<br>the module is powered<br>on.                                             |                                                       |
| 7  | USB_D+               | USB_DP             | AI/AO     | USB 2.0 differential data<br>bus (+)                                                                          |                                                       |
| 8  | W_DISABLE1#          | W_DISABLE1#        | DI        | Airplane mode control.<br>Active low.                                                                         | 1.8/3.3 V power<br>domain                             |
| 9  | USB_D-               | USB_DM             | AI/AO     | USB 2.0 differential data<br>bus (-)                                                                          |                                                       |
| 10 | GPIO_9               | WWAN_LED#          | OD        | RF status indication.<br>Active low.                                                                          |                                                       |
| 11 | GND                  | GND                |           | Ground                                                                                                        |                                                       |
| 12 | Key                  | Notch              |           | Notch                                                                                                         |                                                       |
| 13 | Key                  | Notch              |           | Notch                                                                                                         |                                                       |
| 14 | Key                  | Notch              |           | Notch                                                                                                         |                                                       |
| 15 | Key                  | Notch              |           | Notch                                                                                                         |                                                       |
| 16 | Key                  | Notch              |           | Notch                                                                                                         |                                                       |
| 17 | Key                  | Notch              |           | Notch                                                                                                         |                                                       |
| 18 | Key                  | Notch              |           | Notch                                                                                                         |                                                       |
| 19 | Key                  | Notch              |           | Notch                                                                                                         |                                                       |
| 20 | GPIO_5<br>(AUDIO_0)  | PCM_CLK            | DI        | PCM data bit clock.<br>In master mode, it is an<br>output signal.<br>In slave mode, it is an<br>input signal. | 1.8 V power<br>domain.<br>If unused, keep it<br>open. |
| 21 | CONFIG_0             | CONFIG_0           |           | EM120R-GL: Connected<br>to GND internally;<br>EM160R-GL: NC                                                   |                                                       |
| 22 | GPIO_6<br>(AUDIO_1)  | PCM_DIN            | PO        | PCM data input                                                                                                | 1.8 V power<br>domain                                 |
| 23 | GPIO_11<br>(WOWWAN#) | WAKE_ON_<br>WAN#   | OD        | Wake up the host.<br>Active low.                                                                              | 1.8/3.3 V power<br>domain                             |
| 24 | GPIO_7<br>(AUDIO_2)  | PCM_DOUT<br>/VDDIO | DO/P<br>O | PCM data output;<br>Could be designed to be<br>compatible with 1.8 V<br>power supply.                         | 1.8 V power<br>domain                                 |

|    |                          |             |    |                                         |                                              |
|----|--------------------------|-------------|----|-----------------------------------------|----------------------------------------------|
| 25 | DPR                      | DPR         | DI | Dynamic power reduction.<br>Active low. | 1.8 V power domain.                          |
| 26 | GPIO_10<br>(W_DISABLE2#) | W_DISABLE2# | DI | GNSS enable control.<br>Active low.     | 1.8/3.3 V power domain                       |
| 27 | GND                      | GND         |    | Ground                                  |                                              |
| 28 | GPIO_8<br>(AUDIO_3)      | PCM_SYNC    | IO | PCM data frame synchronization          | 1.8 V power domain                           |
| 29 | USB3.0-TX-               | USB_SS_TX_M | AO | USB 3.0 transmit data (-)               |                                              |
| 30 | UIM-RESET                | USIM1_RST   | DO | (U)SIM1 card reset                      | 1.8/3.0 V power domain                       |
| 31 | USB3.0-TX+               | USB_SS_TX_P | AO | USB 3.0 transmit data (+)               |                                              |
| 32 | UIM-CLK                  | USIM1_CLK   | DO | (U)SIM1 card clock                      | 1.8/3.0 V power domain                       |
| 33 | GND                      | GND         |    | Ground                                  |                                              |
| 34 | UIM-DATA                 | USIM1_DATA  | IO | (U)SIM1 card data                       | Pulled up to USIM1_VDD internally.           |
| 35 | USB3.0-RX-               | USB_SS_RX_M | AI | USB 3.0 receive data (-)                |                                              |
| 36 | UIM-PWR                  | USIM1_VDD   | PO | Power supply for (U)SIM1 card           | 1.8/3.0 V power domain                       |
| 37 | USB3.0-RX+               | USB_SS_RX_P | AI | USB 3.0 receive data (+)                |                                              |
| 38 | N/C                      | NC          |    | NC                                      |                                              |
| 39 | GND                      | GND         |    | Ground                                  |                                              |
| 40 | GPIO_0<br>(SIM_DET2)     | USIM2_DET   | DI | (U)SIM2 card insertion detection        | Pulled up internally.<br>1.8 V power domain. |
| 41 | PETn0                    | PCIE_TX_M   | AO | PCIe transmit data (-)                  |                                              |
| 42 | GPIO_1<br>(SIM_DAT2)     | USIM2_DATA  | IO | (U)SIM2 card data                       | Pulled up to USIM2_VDD internally            |
| 43 | PETp0                    | PCIE_TX_P   | AO | PCIe transmit data (+)                  |                                              |
| 44 | GPIO_2<br>(SIM_CLK2)     | USIM2_CLK   | DO | (U)SIM2 card clock                      | 1.8/3.0 V power domain                       |

|    |                      |               |       |                                    |                                   |
|----|----------------------|---------------|-------|------------------------------------|-----------------------------------|
| 45 | GND                  | GND           |       | Ground                             |                                   |
| 46 | GPIO_3<br>(SIM_RST2) | USIM2_RST     | DO    | (U)SIM2 card reset                 | 1.8/3.0 V power domain            |
| 47 | PERn0                | PCIE_RX_M     | AI    | PCle receive data (-)              |                                   |
| 48 | GPIO_4<br>(SIM_PWR2) | USIM2_VDD     | PO    | Power supply for (U)SIM2 card      | 1.8/3.0 V power domain            |
| 49 | PERp0                | PCIE_RX_P     | AI    | PCle receive data (+)              |                                   |
| 50 | PCIE_RST_N           | PCIE_RST_N    | DI    | PCle reset input. Active low.      | 3.3 V power domain                |
| 51 | GND                  | GND           |       | Ground                             |                                   |
| 52 | PCIE_CLKREQ_N        | PCIE_CLKREQ_N | DO    | PCle clock request. Active low.    | 3.3 V power domain                |
| 53 | REFCLKn              | PCIE_REFCLK_M | AI/AO | PCle reference clock (-)           |                                   |
| 54 | PEWAKE#              | PCIE_WAKE_N   | IO    | PCle wake up the host. Active low. | 3.3 V power domain                |
| 55 | REFCLKp              | PCIE_REFCLK_P | AI/AO | PCle reference clock (+)           |                                   |
| 56 | N/C                  | RFFE_CLK      | DO    | RFFE clock                         |                                   |
| 57 | GND                  | GND           |       | Ground                             |                                   |
| 58 | N/C                  | RFFE_DATA     | IO    | RFFE data                          |                                   |
| 59 | ANTCTL0              | ANTCTL0       | DO    | Antenna tuner control              | 1.8 V power domain                |
| 60 | COEX3                | COEX3         | IO    | COEX GPIO                          | 1.8 V power domain                |
| 61 | ANTCTL1              | ANTCTL1       | DO    | Antenna tuner control              | 1.8 V power domain                |
| 62 | COEX2                | COEX_RXD      | DI    | COEX UART receive data             | 1.8 V power domain                |
| 63 | ANTCTL2              | ANTCTL2       | DO    | Antenna tuner control              | 1.8 V power domain                |
| 64 | COEX1                | COEX_TXD      | DO    | COEX UART transmit data            | 1.8 V power domain                |
| 65 | ANTCTL3              | ANTCTL3       | DO    | Antenna tuner control              | 1.8 V power domain                |
| 66 | SIM_DETECT           | USIM1_DET     | DI    | (U)SIM1 card insertion detection   | Pulled up internally. 1.8 V power |

|    |                |            |    |                                 |                                                 |
|----|----------------|------------|----|---------------------------------|-------------------------------------------------|
|    |                |            |    |                                 | domain.                                         |
| 67 | RESET#         | RESET#     | DI | WWAN reset input<br>Active low. | Pulled up internally.<br>1.8 V power domain.    |
| 68 | SUSCLK (32kHz) | ANT_CONFIG | DI | Antenna configuration           | Pulled up internally.<br>1.8 V power domain.    |
| 69 | CONFIG_1       | CONFIG_1   |    | Connected to GND internally     |                                                 |
| 70 | 3.3V           | VCC        | PI | Power supply                    | Vmin = 3.135 V<br>Vnorm = 3.7 V<br>Vmax = 4.4 V |
| 71 | GND            | GND        |    | Ground                          |                                                 |
| 72 | 3.3V           | VCC        | PI | Power supply                    | Vmin = 3.135 V<br>Vnorm = 3.7 V<br>Vmax = 4.4 V |
| 73 | GND            | GND        |    | Ground                          |                                                 |
| 74 | 3.3V           | VCC        | PI | Power supply                    | Vmin = 3.135 V<br>Vnorm = 3.7 V<br>Vmax = 4.4 V |
| 75 | CONFIG_2       | CONFIG_2   |    | NC                              |                                                 |

**NOTE**

Please keep all NC, reserved and unused pins unconnected.

### 3.3. Power Supply

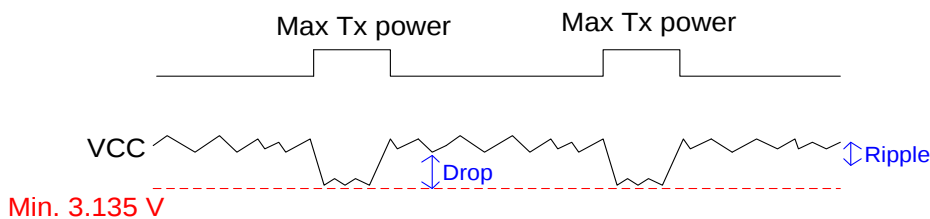
The following table shows definition of VCC pins and ground pins.

**Table 4: Pin Definition of VCC and GND**

| Pin No.                                     | Pin Name | I/O | Power Domain | Description             |
|---------------------------------------------|----------|-----|--------------|-------------------------|
| 2, 4, 70, 72, 74                            | VCC      | PI  | 3.135–4.4 V  | 3.7 V typical DC supply |
| 3, 5, 11, 27, 33, 39, 45,<br>51, 57, 71, 73 | GND      |     |              | Ground                  |

#### 3.3.1. Decrease Voltage Drop

The power supply range of the module is from 3.135 V to 4.4 V. Make sure that the input voltage never drops below 3.135 V, otherwise the module will be powered off automatically. The following figure shows the maximum voltage drop during radio transmission in 3G and 4G networks.



**Figure 3: Power Supply Limits during Radio Transmission**

To decrease voltage drop, a bypass capacitor of about 220  $\mu$ F with low ESR ( $ESR = 0.7 \Omega$ ) should be used, and a multi-layer ceramic chip capacitor (MLCC) array should also be reserved due to its ultra-low ESR. It is recommended to use three ceramic capacitors (100 nF, 33 pF, 10 pF) for composing the MLCC array, and place these capacitors close to VCC pins. The main power supply from an external application must be a single voltage source. The width of VCC trace should be no less than 2 mm. In principle, a longer VCC trace indicates a wider VCC trace.

In addition, in order to get a stable power source, it is recommended to use a zener diode with reverse zener voltage of 5.1 V and dissipation power more than 0.5 W. The following figure shows a reference

circuit of VCC.

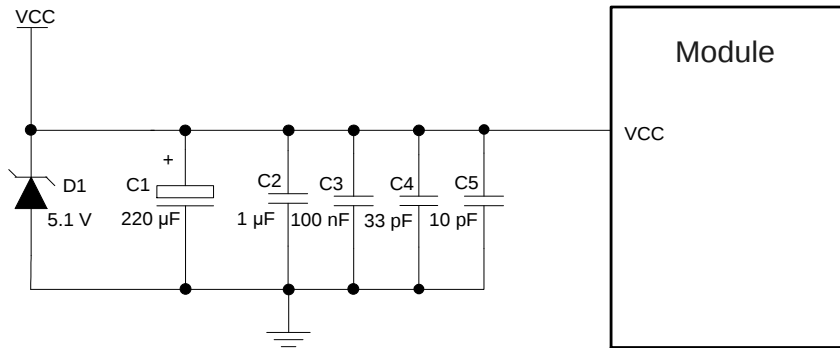


Figure 4: Reference Circuit of VCC

### 3.3.2. Reference Design for Power Supply

Power design for the module is very important, as the performance of the module largely depends on the power source. The power supply can provide sufficient current (at least 2.5 A). If the voltage drop between the input and output is not too high, an LDO is suggested to be used to supply power for the module. If there is a big voltage difference between the input source and the desired output (VCC), a buck converter is preferred to be used as the power supply.

The following figure shows a reference design for +5 V input power source. The typical output of the power supply is about 3.7 V and the maximum load current is 3 A.

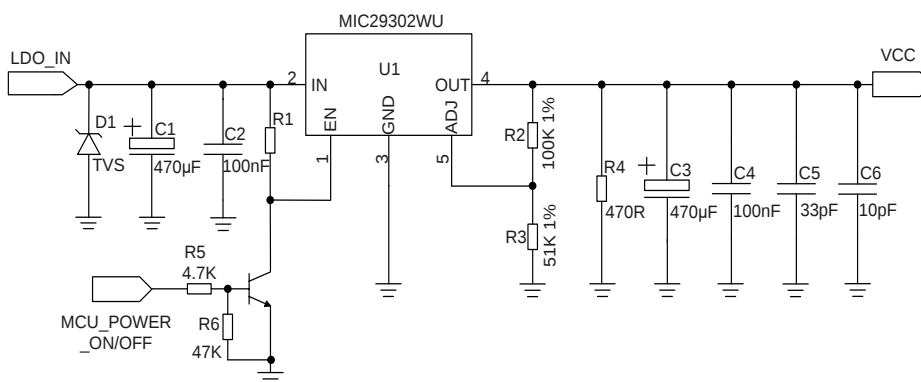


Figure 5: Reference Design of Power Supply

**NOTE**

In order to avoid damages to the internal flash, do not cut off the power supply directly when the module is working. It is suggested that the power supply should be cut off after the module is shut down.

### 3.4. Turn-on and Turn-off Scenarios

#### 3.4.1. Turn on the Module

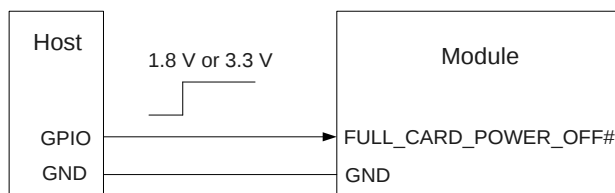
Pulling up the FULL\_CARD\_POWER\_OFF# pin will power on the module. The following table shows the pin definition of FULL\_CARD\_POWER\_OFF#.

**Table 5: Pin Definition of FULL\_CARD\_POWER\_OFF#**

| Pin Name             | Pin No. | Description                                                                                                                           | DC Characteristics                                                                      | Comment                 |
|----------------------|---------|---------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------|-------------------------|
| FULL_CARD_POWER_OFF# | 6       | Turn on/off the module.<br>When it is at low level, the module is powered off.<br>When it is at high level, the module is powered on. | $V_{IHmax} = 4.4\text{ V}$<br>$V_{IHmin} = 1.19\text{ V}$<br>$V_{ILmax} = 0.2\text{ V}$ | Pulled down internally. |

##### 3.4.1.1. Turn on the Module with a Host GPIO

It is recommended to use a host GPIO to control FULL\_CARD\_POWER\_OFF#. A simple reference circuit is illustrated in the following figure.

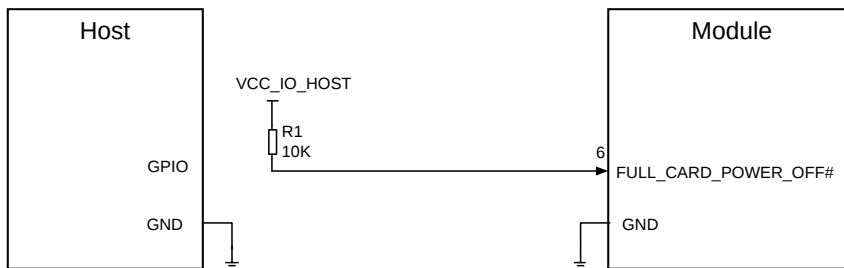


**Figure 6: Turn on the Module with a Host GPIO**

### 3.4.1.2. Turn on the Module Automatically

If FULL\_CARD\_POWER\_OFF# is pulled up to VCC with a 5–10 k $\Omega$  resistor, the module will be powered on automatically when the power supply for VCC is applied.

A reference circuit is shown in the following figure.



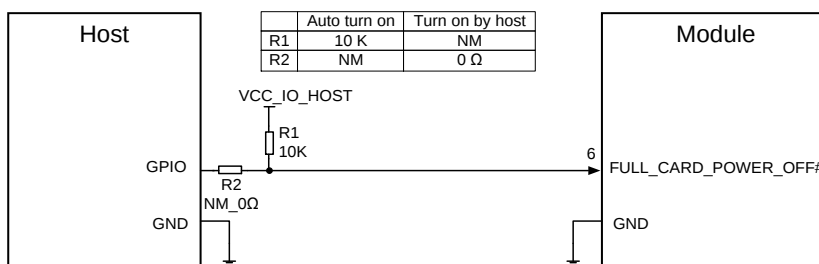
**Notes:**

1. The voltage of pin 6 should be no less than 1.19 V when it is at HIGH level.
2. The voltage level VCC\_IO\_HOST could be a 1.8 V or 3.3 V typically.

**Figure 7: Turn on the Module Automatically**

### 3.4.1.3. Turn on the Module with Compatible Design

The following figure shows a compatible design to turn on the module automatically after power-up or by host.



**Notes:**

1. The voltage of pin 6 should be no less than 1.19 V when it is at HIGH level.
2. The voltage level VCC\_IO\_HOST could be 1.8 V or 3.3 V typically.

**Figure 8: Turn on the Module with Compatible Design**

The turn-on scenario is illustrated in the following figure.

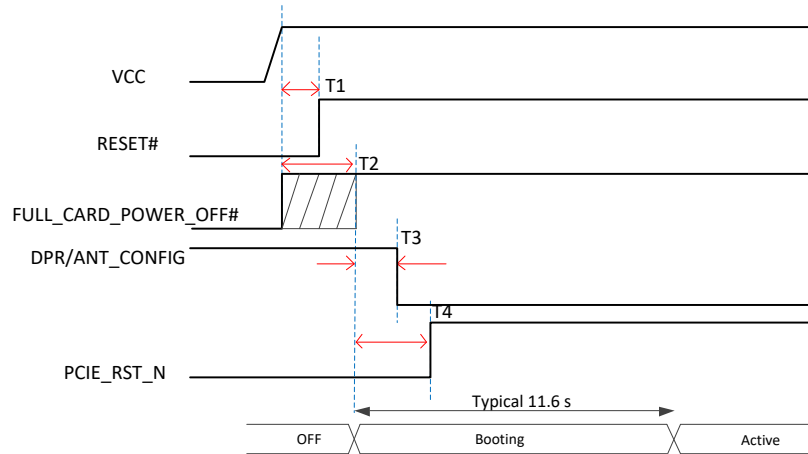


Figure 9: Turn-on Timing of the Module

Table 6: Description of Turn-on Timing of the Module

| Index | Min. | Typical | Max.  | Comment                                                                                                                       |
|-------|------|---------|-------|-------------------------------------------------------------------------------------------------------------------------------|
| T1    | 0 ms | 50 ms   | -     | RESET# is pulled up internally, and it would be de-asserted 50 ms after VCC is powered on.                                    |
| T2    | 0 ms | 20 ms   | -     | FULL_CARD_POWER_OFF# could be de-asserted before or after RESET#, 20 ms is a recommended value when it is controlled by GPIO. |
| T3    | 0 ms | 15 ms   | 20 ms | DPR or ANT_CONFIG should be asserted before modem initialize.                                                                 |
| T4    | -    | 100 ms  | -     | PCIE_RST_N should be de-asserted 100 ms after FULL_CARD_POWER_OFF#.                                                           |

### 3.4.2. Turn off the Module

#### 3.4.2.1. Turn off the Module through FULL\_CARD\_POWER\_OFF#

Pulling down the FULL\_CARD\_POWER\_OFF# pin will turn off the module. The turn-off scenario is illustrated in the following figure.

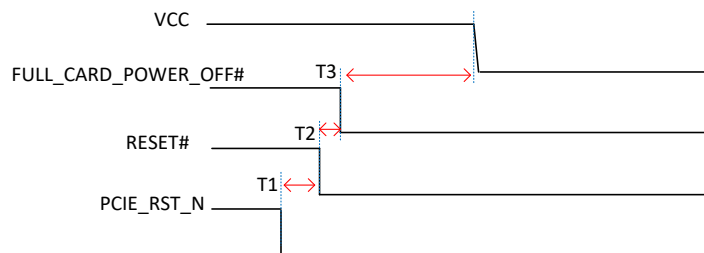


Figure 10: Timing of Turning off the Module through FULL\_CARD\_POWER\_OFF#

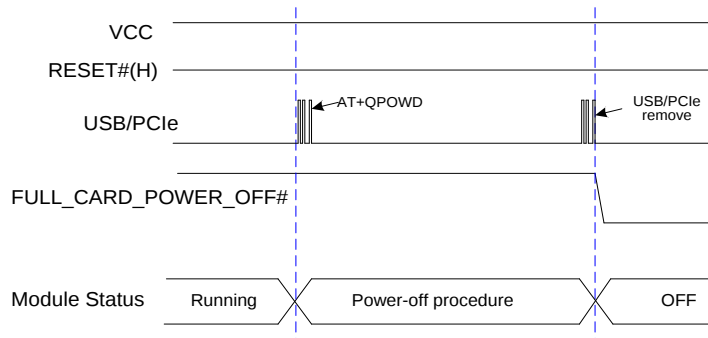
Table 7: Description of the Timing of Resetting the Module through FULL\_CARD\_POWER\_OFF#

| Index | Min.  | Typical | Max.   | Comments                                                         |
|-------|-------|---------|--------|------------------------------------------------------------------|
| T1    | 0 ms  | 20 ms   | -      | PCIE_RST_N should be asserted before RESET#.                     |
| T2    | 0 ms  | 10 ms   | 200 ms | RESET# is recommended to be asserted before FULL_CARD_POWER_OFF# |
| T3    | 10 ms | -       | -      | If power is always on, it could be ignored.                      |

#### 3.4.2.2. Turn off the Module through AT Command

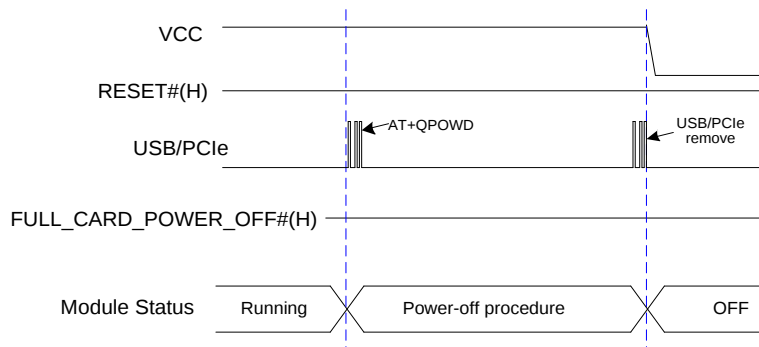
It is a safe way to use **AT+QPOWD** command to turn off the module. For more details about the command, refer to **document [3]**.

For the circuit design of **Figure 6**, pull down FULL\_CARD\_POWER\_OFF# pin, or cut off power supply of VCC after the module's USB/PCIe is removed. Otherwise, the module will be powered on again.



**Figure 11: Timing of Turning off the Module through AT Command and FULL\_CARD\_POWER\_OFF#**

For the circuit design of **Figure 7**, cut off power supply of VCC after the module's USB/PCIe is removed, as illustrated in **Figure 11**. Otherwise, the module will be powered on again.



**Figure 12: Timing of Turning off the Module through AT Command and Power Supply**

**NOTE**

Please pull down FULL\_CARD\_POWER\_OFF# pin immediately or cut off the power supply of VCC when the host detects that the module is removed.

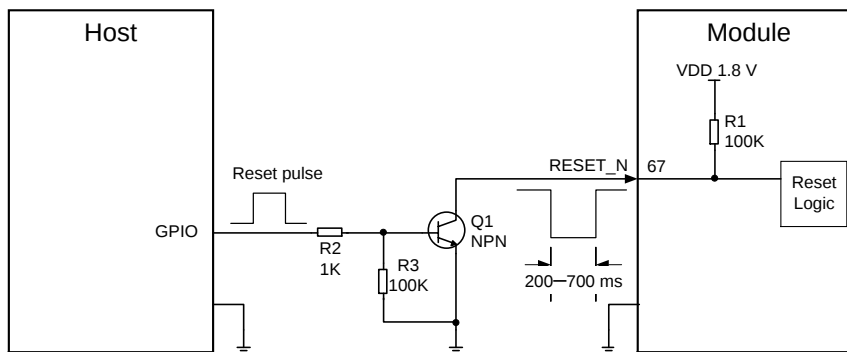
### 3.5. Reset

The RESET# pin is used to reset the module. The module can be reset by driving RESET# to a low-level voltage for 200–700 ms.

**Table 8: Pin Definition of RESET#**

| Pin Name | Pin No. | Description      | DC Characteristics                                                                     | Comment                                      |
|----------|---------|------------------|----------------------------------------------------------------------------------------|----------------------------------------------|
| RESET#   | 67      | Reset the module | $V_{IHmax} = 2.1\text{ V}$<br>$V_{IHmin} = 1.3\text{ V}$<br>$V_{ILmax} = 0.5\text{ V}$ | Pulled up internally.<br>1.8 V power domain. |

An open collector/drain driver or button can be used to control the RESET# pin.



**Figure 13: Reference Circuit of RESET\_N with NPN Driving Circuit**

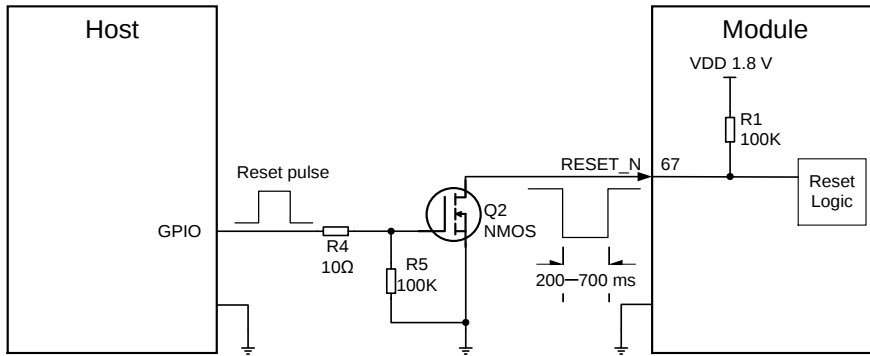
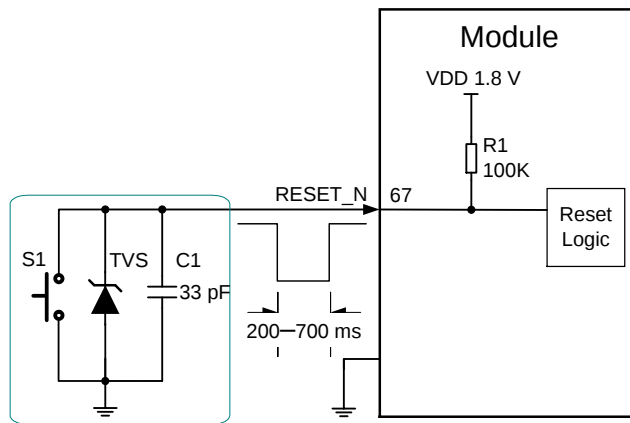


Figure 14: Reference Circuit of RESET\_N with NMOS Driving Circuit



**Note:** The capacitor C1 is recommended to be less than 47 pF.

Figure 15: Reference Circuit of RESET\_N with Button

The reset scenario is illustrated in the following figure.

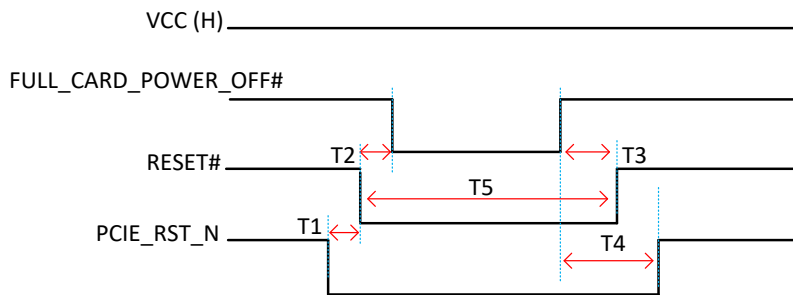


Figure 16: Timing of Resetting the Module

Table 9: Timing of Resetting the Module

| Index | Min.   | Typical | Max.   | Comments                                                                                            |
|-------|--------|---------|--------|-----------------------------------------------------------------------------------------------------|
| T1    | 0 ms   | 20 ms   | -      | PCIE_RST_N should be asserted before RESET#.                                                        |
| T2    | 0 ms   | 10 ms   | 200 ms | RESET# should be asserted before FULL_CARD_POWER_OFF#.                                              |
| T3    | 0 ms   | 20 ms   | 200 ms | RESET# should be de-asserted after FULL_CARD_POWER_OFF#.                                            |
| T4    | -      | 100 ms  | -      | PCIE_RST_N should be de-asserted 100 ms after FULL_CARD_POWER_OFF#.                                 |
| T5    | 200 ms | -       | 700 ms | RESET# should be de-asserted no longer than 700 ms, otherwise the module would reset several times. |

**NOTE**

Please ensure that there is no large capacitance on RESET# pin.

### 3.6. (U)SIM Interfaces

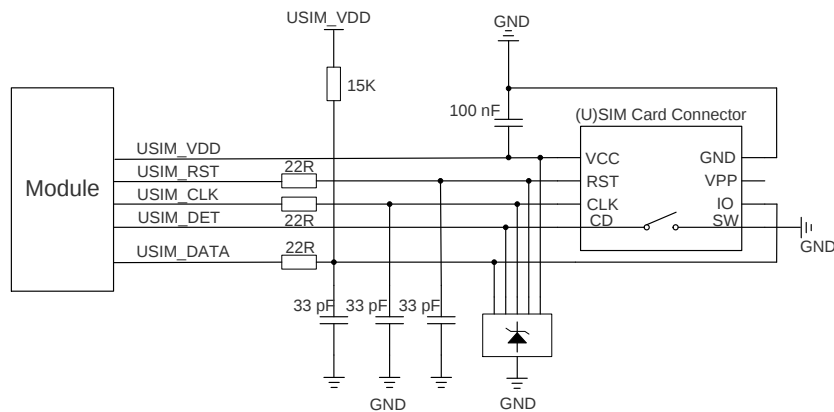
The (U)SIM interfaces circuitry meets ETSI and IMT-2000 requirements. Both 1.8 V and 3.0 V (U)SIM cards are supported, and Dual SIM Single Standby\* function is supported.

**Table 10: Pin Definition of (U)SIM Interfaces**

| Pin Name   | Pin No. | I/O | Description                                       | Comment                                                                                                                         |
|------------|---------|-----|---------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------|
| USIM1_VDD  | 36      | PO  | Power supply for (U)SIM1 card                     | Either 1.8 V or 3.0 V is supported by the module automatically.                                                                 |
| USIM1_DATA | 34      | IO  | (U)SIM1 card data                                 |                                                                                                                                 |
| USIM1_CLK  | 32      | DO  | (U)SIM1 card clock                                |                                                                                                                                 |
| USIM1_RST  | 30      | DO  | (U)SIM1 card reset                                |                                                                                                                                 |
| USIM1_DET  | 66      | DI  | (U)SIM1 card insertion detection.<br>Active high. | Internally pulled up.<br>When (U)SIM1 card is present, it is at high level.<br>When (U)SIM1 card is absent, it is at low level. |
| USIM2_VDD  | 48      | PO  | Power supply for (U)SIM2 card                     | Either 1.8 V or 3.0 V is supported by the module automatically.                                                                 |
| USIM2_DATA | 42      | IO  | (U)SIM2 card data                                 |                                                                                                                                 |
| USIM2_CLK  | 44      | DO  | (U)SIM2 card clock                                |                                                                                                                                 |
| USIM2_RST  | 46      | DO  | (U)SIM2 card reset                                |                                                                                                                                 |
| USIM2_DET  | 40      | DI  | (U)SIM2 card insertion detection.<br>Active high. | Internally pulled up.<br>When (U)SIM2 card is present, it is at high level.<br>When (U)SIM2 card is absent, it is at low level. |

EM120R-GL&EM160R-GL support (U)SIM card hot-plug via the USIM\_DET pin, which is a level trigger pin. The USIM\_DET is normally short-circuited to ground when (U)SIM card is not inserted. When the (U)SIM card is inserted, the USIM\_DET will change from low to high level. The rising edge will indicate insertion of the (U)SIM card. When the (U)SIM card is removed, the USIM\_DET will change from high to low level. This falling edge will indicate the absence of the (U)SIM card.

The following figure shows a reference design for a (U)SIM interface with normally closed (U)SIM card connector.

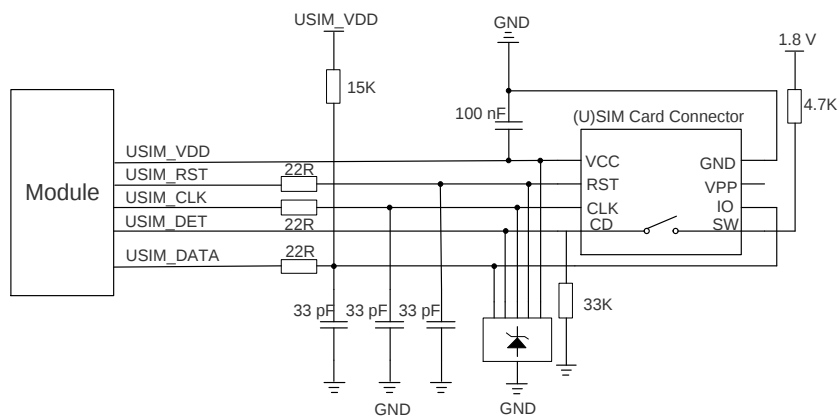


**Figure 17: Reference Circuit of Normally Closed (U)SIM1 Card Connector**

### Normally Closed (U)SIM Card Connector:

- When the (U)SIM is absent, CD is short-circuited to SW and USIM\_DET is at low level.
- When the (U)SIM is inserted, CD is open to SW and USIM\_DET is at high level.

The following figure shows a reference design for a (U)SIM interface with normally open (U)SIM card connector.

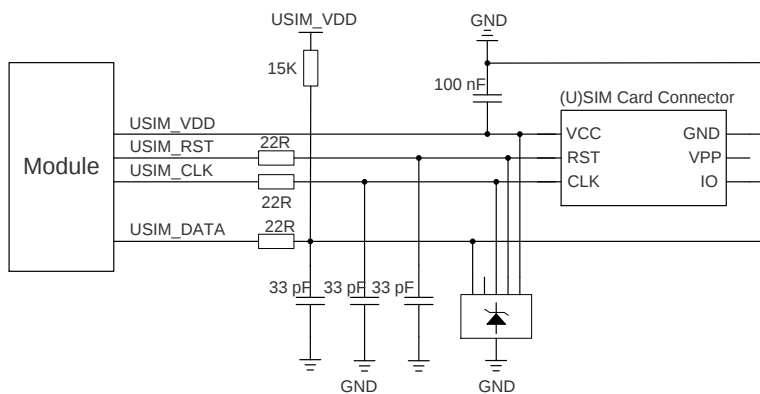


**Figure 18: Reference Circuit of Normally Open (U)SIM1 Card Connector**

#### Normally Open (U)SIM Card Connector:

- When the (U)SIM is absent, CD is open to SW and USIM\_DET is at low level.
- When the (U)SIM is inserted, CD is short-circuited to SW and USIM\_DET is at high level.

If (U)SIM card detection function is not needed, keep USIM\_DET unconnected. The following figure shows a reference circuit for a (U)SIM card interface with a 6-pin (U)SIM card connector.

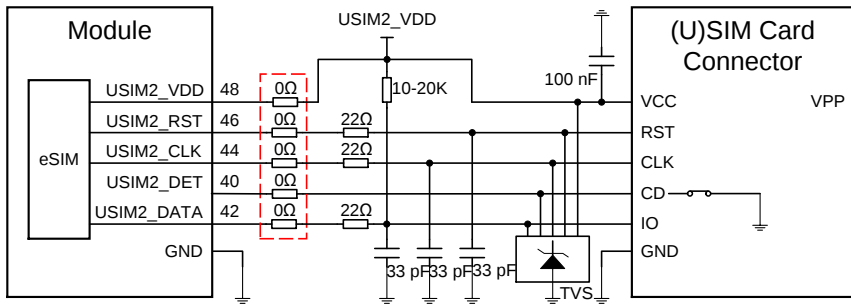


**Figure 19: Reference Circuit of a 6-Pin (U)SIM1 Card Connector**

EM120R-GL&EM160R-GL provide two (U)SIM interfaces. (U)SIM1 interface is used for external (U)SIM card only, and (U)SIM2 interface is used for external (U)SIM card or internal eSIM card.

It should be noted that, when (U)SIM2 interface is used for an external (U)SIM card, the reference circuits are the same as those of (U)SIM1 interface. When (U)SIM2 interface is used for the internal eSIM card, pins 40, 42, 44, 46 and 48 of the module must be kept open.

A recommended compatible design of (U)SIM2 interface is shown below.



**Note:** The five 0Ω resistors must be close to M.2 socket connector, and all other components should be close to (U)SIM card connector in PCB layout.

**Figure 20: Recommended Compatible Design of (U)SIM2 Interface**

In order to enhance the reliability and availability of the (U)SIM card in customers' applications, follow the criteria below when designing the (U)SIM circuit:

- Keep placement of (U)SIM card connector as close as possible to the module. Keep the trace length as less than 200 mm as possible.
- Keep (U)SIM card signals away from RF and VCC traces.
- Assure the ground between the module and the (U)SIM card connector short and wide. Keep the trace width of ground and USIM\_VDD no less than 0.5 mm to maintain the same electric potential.
- To avoid cross-talk between USIM\_DATA and USIM\_CLK, keep them away from each other and shield them with surrounded ground.
- In order to offer good ESD protection, it is recommended to add a TVS diode array with parasitic capacitance not exceeding 10 pF. The 22 Ω resistors should be added in series between the module and the (U)SIM card connector so as to suppress EMI spurious transmission and enhance ESD protection. The 33 pF capacitors are used to filter out RF interference. Note that the (U)SIM peripheral circuit should be close to the (U)SIM card connector.
- The pull-up resistor on USIM\_DATA trace can improve anti-jamming capability when long layout trace and sensitive occasion are applied, and should be placed close to the (U)SIM card connector.

**NOTE**

“\*” means under development.

### 3.7. USB Interface

EM120R-GL&EM160R-GL provide one integrated Universal Serial Bus (USB) interface which complies with the USB 3.0/2.0 specifications and supports super speed (5 Gbps) on USB 3.0, high speed (480 Mbps) and full speed (12 Mbps) modes on USB 2.0. The USB interface is used for AT command communication, data transmission, GNSS NMEA sentences output, software debugging, firmware upgrade and voice over USB\*.

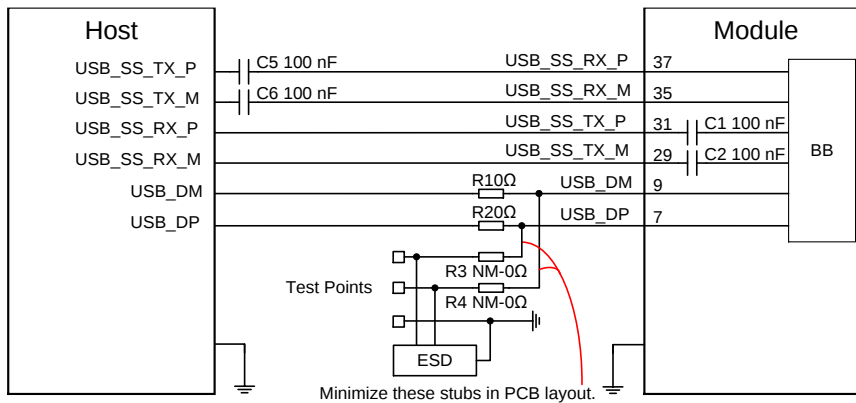
The following table shows the pin definition of USB interface.

**Table 11: Pin Definition of USB Interface**

| Pin No. | Pin Name    | I/O   | Description                       | Comment                                       |
|---------|-------------|-------|-----------------------------------|-----------------------------------------------|
| 7       | USB_DP      | AI/AO | USB 2.0 differential data bus (+) | Require differential impedance of 90 $\Omega$ |
| 9       | USB_DM      | AI/AO | USB 2.0 differential data bus (-) |                                               |
| 29      | USB_SS_TX_M | AO    | USB 3.0 transmit data (-)         | Require differential impedance of 90 $\Omega$ |
| 31      | USB_SS_TX_P | AO    | USB 3.0 transmit data (+)         |                                               |
| 35      | USB_SS_RX_M | AI    | USB 3.0 receive data (-)          | Require differential impedance of 90 $\Omega$ |
| 37      | USB_SS_RX_P | AI    | USB 3.0 receive data (+)          |                                               |

For more details about the USB 3.0 & 2.0 specifications, visit <http://www.usb.org/home>.

The USB 2.0 interface is recommended to be reserved for firmware upgrade in customers' designs. The following figure shows a reference circuit of USB 3.0/USB 2.0 interface.



**Figure 21: Reference Circuit of USB 3.0/2.0 Interface**

AC coupling capacitors C5 and C6 must be placed close to the host and close to each other. C1 and C2 have been integrated inside the module, so do not place these two capacitors on customers' schematic and PCB. In order to ensure the signal integrity of USB 2.0 data traces, R1, R2, R3 and R4 components must be placed close to the module, and the stubs must be minimized in PCB layout.

In order to ensure that the USB interface designs correspond with USB specifications, comply with the following principles.

- It is important to route the USB 2.0 & 3.0 signal traces as differential pairs with total grounding. The impedance of USB differential trace is 90 Ω.
- For USB 2.0 signal traces, the trace lengths must be less than 120 mm, and the differential data pair matching is less than 2 mm (15 ps).
- For USB 3.0 signal traces, the maximum length of TX and RX differential data pair is recommended to be less than 100 mm, and the TX and RX differential data pair matching is less than 0.7 mm (5 ps).
- Do not route signal traces under crystals, oscillators, magnetic devices or RF signal traces. It is important to route the USB 2.0 & 3.0 differential traces in inner-layer with ground shielding on not only upper and lower layers but also right and left sides.
- If USB connector is used, keep the ESD protection components as close as possible to the USB connector. Pay attention to the influence of junction capacitance of ESD protection components on USB 2.0 & 3.0 data traces. Typically, the capacitance value should be less than 2.0 pF for USB 2.0, and less than 0.4 pF for USB 3.0.
- If possible, reserve four 0 Ω resistors (R1–R4) on USB\_DP and USB\_DM traces, as shown in the above figure.

**NOTE**

“\*\*” means under development.

### 3.8. PCIe Interface

EM120R-GL and EM160R-GL provide one integrated PCIe (Peripheral Component Interconnect Express) interface which complies with the *PCI Express Specification, Revision 2.1* and supports 5 Gbps per lane. The PCIe interface is used for data transmission, GNSS NMEA sentences output, software debugging and firmware upgrade.

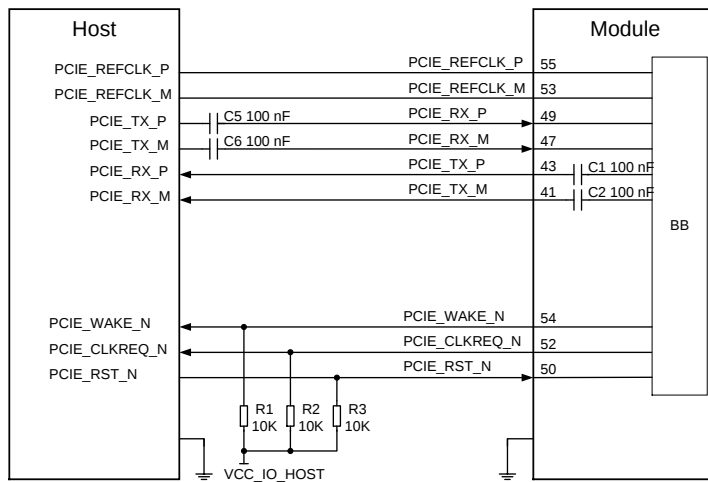
The following table shows the pin definition of PCIe interface.

**Table 12: Pin Definition of PCIe Interface**

| Pin No. | Pin Name      | I/O   | Description                           | Comment                                         |
|---------|---------------|-------|---------------------------------------|-------------------------------------------------|
| 55      | PCIE_REFCLK_P | AI/AO | PCIe reference clock (+)              | Require differential impedance of 95 $\Omega$ . |
| 53      | PCIE_REFCLK_M | AI/AO | PCIe reference clock (-)              |                                                 |
| 49      | PCIE_RX_P     | AI    | PCIe receive data (+)                 | Require differential impedance of 95 $\Omega$   |
| 47      | PCIE_RX_M     | AI    | PCIe receive data (-)                 |                                                 |
| 43      | PCIE_TX_P     | AO    | PCIe transmit data (+)                | Require differential impedance of 95 $\Omega$   |
| 41      | PCIE_TX_M     | AO    | PCIe transmit data (-)                |                                                 |
| 50      | PCIE_RST_N    | DI    | PCIe reset input.<br>Active low.      | 3.3 V power domain                              |
| 52      | PCIE_CLKREQ_N | DO    | PCIe clock request.<br>Active low.    | 3.3 V power domain                              |
| 54      | PCIE_WAKE_N   | DO    | PCIe wake up the host.<br>Active low. | 3.3 V power domain                              |

### 3.8.1. Endpoint Mode

EM120R-GL and EM160R-GL support endpoint (EP) mode. In this mode, the modules are configured as a PCIe EP device. The following figure shows a reference circuit of PCIe endpoint mode.



**Note:** The voltage level VCC\_IO\_HOST depends on the host side due to open drain in pin 50, 52 and 54.

**Figure 22: PCIe Interface Reference Circuit (EP Mode)**

In order to ensure the signal integrity of PCIe interface, AC coupling capacitors C5 and C6 should be placed close to the host on PCB. C1 and C2 have been integrated inside the module, so do not place these two capacitors on customers' schematic and PCB.

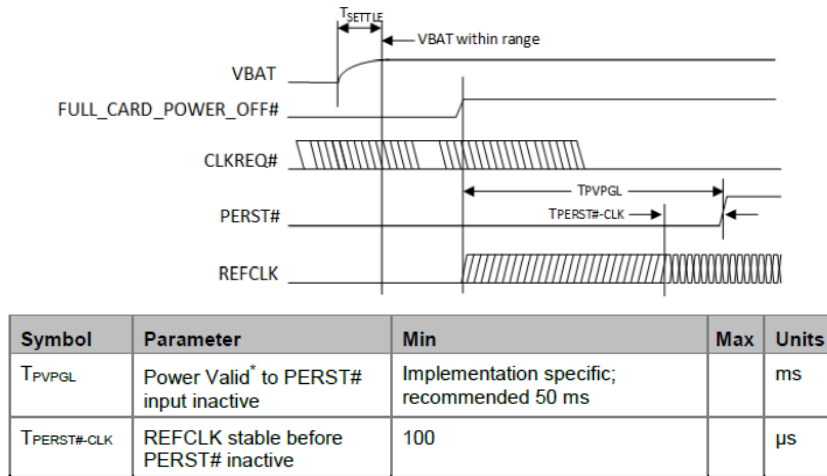


Figure 23: PCIe Power-on Timing Requirements of M.2 Specification

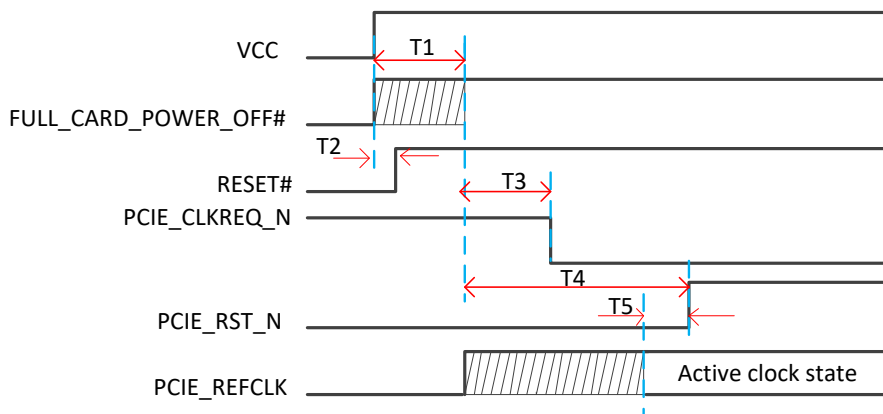


Figure 24: PCIe Power-on Timing Requirements of the Module

**Table 13: Description of PCIe Power-on Timing Requirements of the Module**

| Index | Min.        | Typical | Max. | Comment                                                                                                                                                                       |
|-------|-------------|---------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| T1    | 0 ms        | 20 ms   | -    | FULL_CARD_POWER_OFF# could be de-asserted before or after RESET#, 20 ms is a recommended value when it is controlled by GPIO.                                                 |
| T2    | -           | 50 ms   | -    | RESET# is pulled up internally, and it would be de-asserted 50 ms after VCC is powered on.                                                                                    |
| T3    | -           | 70 ms   | -    | PCIE_CLKREQ_N would be asserted 70 ms after FULL_CARD_POWER_OFF#.                                                                                                             |
| T4    | -           | 100 ms  | -    | PCIE_RST_N should be de-asserted after PCIE_CLKREQ_N.                                                                                                                         |
| T5    | 100 $\mu$ s | -       | -    | The host must ensure that the reference clock is in the active clock state for at least a period specified by T <sub>PCIE_RST_N-CLK</sub> , prior to PCIE_RST_N de-assertion. |

The following principles of PCIe interface design should be complied with so as to meet PCIe V2.1 specifications.

- It is important to route the PCIe signal traces as differential pairs with total grounding.
- For PCIe signal traces, the TX and RX differential data pair maximum length is recommended to be less than 250 mm, the TX and RX differential data pair matching are less than 0.7 mm (5 ps).
- Do not route signal traces under crystals, oscillators, magnetic devices or RF signal traces. It is important to route the PCIe differential traces in inner-layer with ground shielding on not only upper and lower layers but also right and left sides.

### 3.8.2. USB Version and PCIe Only Version

Beginning with ES2 (engineering samples), EM120R-GL&EM160R-GL support USB version and PCIe only version described as below:

#### USB version:

- Support all USB 3.0/2.0 features
- Support MBIM/QMI/QRTR/AT
- Support firmware upgrade

#### PCIe only version:

- Support MBIM/QMI/QRTR/AT
- Support BIOS PCIe early initial
- Support firmware upgrade

If EM120R-GL&EM160R-GL work at PCIe only version by burnt eFuse, the modules cannot switch back to USB version.

### 3.9. PCM Interface\*

EM120R-GL&EM160R-GL support audio communication via Pulse Code Modulation (PCM) digital interface. The PCM interface supports the following modes:

- Primary mode (short frame synchronization, works as both master and slave)
- Auxiliary mode (long frame synchronization, works as master only)

In primary mode, the data is sampled on the falling edge of the PCM\_CLK and transmitted on the rising edge. The PCM\_SYNC falling edge represents the MSB. In this mode, the PCM interface supports 256, 512, 1024 or 2048 kHz PCM\_CLK at 8 kHz PCM\_SYNC, and also supports 4096 kHz PCM\_CLK at 16 kHz PCM\_SYNC.

In auxiliary mode, the data is sampled on the falling edge of the PCM\_CLK and transmitted on the rising edge. The PCM\_SYNC rising edge represents the MSB. In this mode, PCM interface operates with a 256 kHz PCM\_CLK and an 8 kHz, 50% duty cycle PCM\_SYNC only.

EM120R-GL&EM160R-GL support 16-bit linear data format. The following figures show the primary mode's timing relationship with 8 kHz PCM\_SYNC and 2048 kHz PCM\_CLK, as well as the auxiliary mode's timing relationship with 8 kHz PCM\_SYNC and 256 kHz PCM\_CLK.

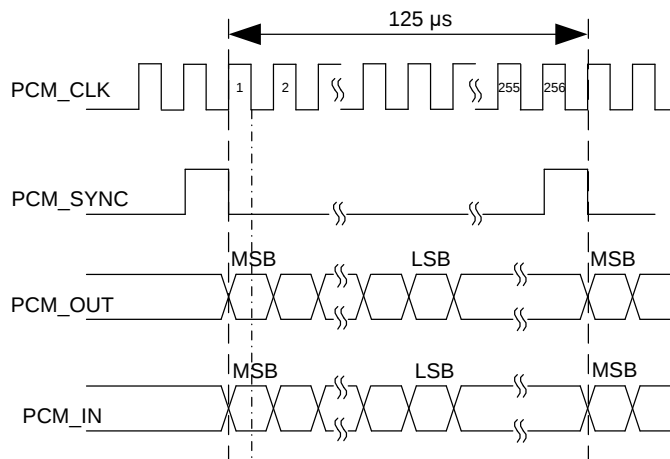
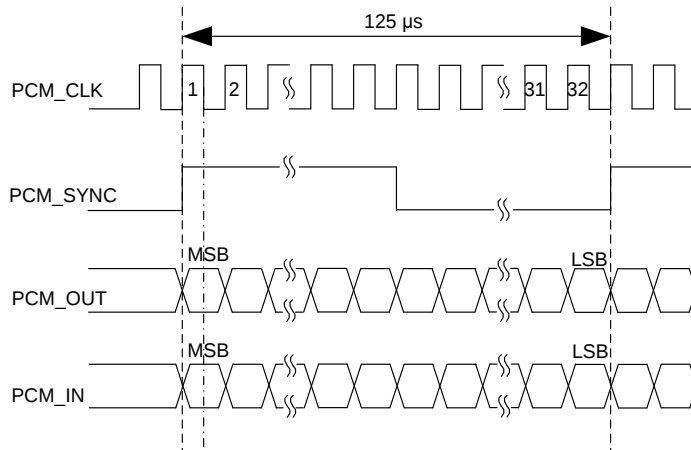


Figure 25: Primary Mode Timing



**Figure 26: Auxiliary Mode Timing**

The following table shows the pin definition of PCM interface which can be applied on audio codec design.

**Table 14: Pin Definition of PCM Interface**

| Pin Name | Pin No. | I/O | Description                                                                                            | Comment                                         |
|----------|---------|-----|--------------------------------------------------------------------------------------------------------|-------------------------------------------------|
| PCM_DIN  | 22      | DI  | PCM data input                                                                                         | 1.8 V power domain                              |
| PCM_DOUT | 24      | DO  | PCM data output                                                                                        | 1.8 V power domain                              |
| PCM_SYNC | 28      | IO  | PCM data frame synchronization                                                                         | 1.8 V power domain                              |
| PCM_CLK  | 20      | IO  | PCM data bit clock<br>In master mode, it is an output signal.<br>In slave mode, it is an input signal. | 1.8 V power domain.<br>If unused, keep it open. |

The clock and mode can be configured by AT command, and the default configuration is master mode using short frame synchronization format with 2048 kHz PCM\_CLK and 8 kHz PCM\_SYNC. Refer to **document [3]** for details about **AT+QDAI** command.

**NOTE**

“\*” means under development.

### 3.10. Control and Indicator Signals\*

The following table shows the pin definition of control and indicator signals.

**Table 15: Definition of Control and Indicator Signals**

| Pin Name     | Pin No. | I/O | Power Domain | Description                             |
|--------------|---------|-----|--------------|-----------------------------------------|
| WWAN_LED#    | 10      | OD  | 3.3 V        | RF status indication.<br>Active low.    |
| WAKE_ON_WAN# | 23      | OD  | 1.8/3.3 V    | Wake up the host.<br>Active low.        |
| W_DISABLE1#  | 8       | DI  | 1.8/3.3 V    | Airplane mode control.<br>Active low.   |
| W_DISABLE2#  | 26      | DI  | 1.8/3.3 V    | GNSS enable control.<br>Active low.     |
| DPR          | 25      | DI  | 1.8 V        | Dynamic power reduction.<br>Active low. |
| ANT_CONFIG   | 68      | DI  | 1.8 V        | Antenna configuration pin.              |

**NOTE**

“\*” means under development.

#### 3.10.1. W\_DISABLE1# Signal

EM120R-GL&EM160R-GL provide a W\_DISABLE1# signal to disable or enable airplane mode through hardware operation. The W\_DISABLE1# pin is pulled up by default. Driving it to low level will let the module enter airplane mode. In airplane mode, the RF function will be disabled.

The RF function can also be enabled or disabled through software AT commands. The following table shows the RF function status of the modules.

**Table 16: RF Function Status**

| W_DISABLE1# Level | AT Commands                                              | RF Function Status |
|-------------------|----------------------------------------------------------|--------------------|
| High Level        | <b>AT+CFUN=1</b>                                         | Enabled            |
| High Level        | <b>AT+CFUN=0</b><br><b>AT+CFUN=4</b>                     | Disabled           |
| Low Level         | <b>AT+CFUN=0</b><br><b>AT+CFUN=1</b><br><b>AT+CFUN=4</b> | Disabled           |

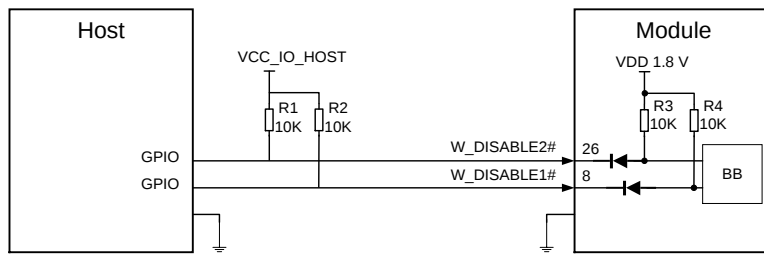
### 3.10.2. W\_DISABLE2# Signal

EM120R-GL&EM160R-GL provide a W\_DISABLE2# pin to disable or enable the GNSS function. The W\_DISABLE2# pin is pulled up by default. Driving it to low level will disable the GNSS function. The combination of W\_DISABLE2# pin and AT commands can control the GNSS function.

**Table 17: GNSS Function Status**

| W_DISABLE2# Level | AT Commands      | GNSS Function Status |
|-------------------|------------------|----------------------|
| High Level        | <b>AT+QGPS=1</b> | Enabled              |
| High Level        | <b>AT+QGSEND</b> | Disabled             |
| Low Level         | <b>AT+QGPS=1</b> |                      |
| Low Level         | <b>AT+QGSEND</b> |                      |

A simple level shifter based on diodes is used on W\_DISABLE1# pin and W\_DISABLE2# pin which are pulled up to a 1.8 V voltage in the module, as shown in the following figure. So, the control signals (GPIO) of the host device could be a 1.8 V or 3.3 V voltage level and pull-up resistor is not needed on the host side. These two signals are active low, and a reference circuit is shown below.



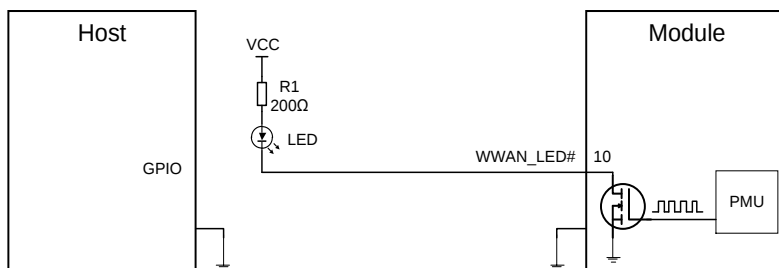
**Note:**  
Host's GPIO could be a 1.8 V or 3.3 V voltage level.

Figure 27: W\_DISABLE1# and W\_DISABLE2# Reference Circuit

### 3.10.3. WWAN\_LED# Signal

The WWAN\_LED# signal is used to indicate RF status of the modules, and its typical current consumption is up to 10 mA.

In order to reduce the current consumption of the LED, a resistor must be placed in series with the LED, as illustrated in the figure below. The LED is ON when the WWAN\_LED# signal is at a low voltage level.



**Note:** This VCC could be the power supply of the module.

Figure 28: WWAN\_LED# Signal Reference Circuit

The following table shows the RF status indicated by WWAN\_LED# signal.

**Table 18: RF Status Indications of WWAN\_LED# Signal**

| WWAN_LED# Level | LED | RF Status |
|-----------------|-----|-----------|
| Low Level       | On  | On        |
| High Level      | Off | Off       |

**NOTE**

RF function is turned off if any of the following circumstances occurs:

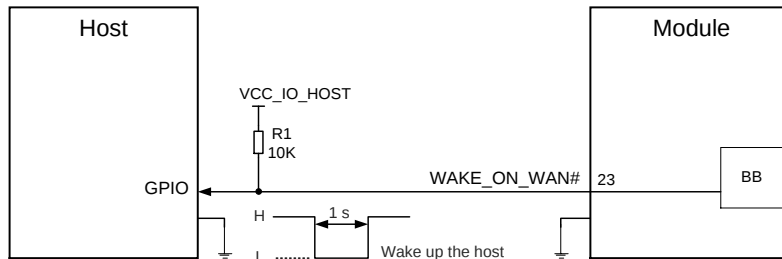
- The (U)SIM card is not working.
- W\_DISABLE1# signal is at low level (airplane mode enabled).

### 3.10.4. WAKE\_ON\_WAN# Signal

The WAKE\_ON\_WAN# signal is an open collector signal, which requires a pull-up resistor on the host. When a URC returns, a 1s low level pulse signal will be outputted to wake up the host. The module operation status indicated by WAKE\_ON\_WAN# is shown as below.

**Table 19: State of the WAKE\_ON\_WAN# Signal**

| WAKE_ON_WAN# State                 | Module Operation Status                         |
|------------------------------------|-------------------------------------------------|
| Output a 1s low level pulse signal | Call/SMS/Data is incoming (to wake up the host) |
| Always at high level               | Idle/Sleep                                      |



**Note:** The voltage level on VCC\_IO\_HOST depends on the host side due to open drain in pin 23.

**Figure 29: WAKE\_ON\_WAN# Signal Reference Circuit Design**

### 3.10.5. DPR

EM120R-GL&EM160R-GL provide a DPR (Dynamic Power Reduction) signal for body SAR (Specific Absorption Rate) detection. The signal is sent by a host system proximity sensor to EM120R-GL&EM160R-GL modules to provide an input trigger which will reduce the output power in the radio transmission.

**Table 20: Function of the DPR Signal**

| DPR Level     | Function                                                                          |
|---------------|-----------------------------------------------------------------------------------|
| High/Floating | Max transmitting power will NOT back off                                          |
| Low           | Max transmitting power will back off by executing <b>AT+QCFG="sarcfg"</b> command |

#### NOTE

Please refer to **document [3]** for more details about **AT+QCFG="sarcfg"** command.

### 3.10.6. ANT\_CONFIG Signal

EM160R-GL provides an ANT\_CONFIG signal for antenna configuration, however, EM120R-GL does not support it since EM120R-GL only supports 2 antennas. The signal is sent by a host system to EM160R-GL module. ANT\_CONFIG is an input port which is pulled high internally by default. The definition of ANT\_CONFIG signal is shown as below table.

**Table 21: Pin Definition of ANT\_CONFIG of EM160R-GL**

| ANT_CONFIG Level | Function           |
|------------------|--------------------|
| High/Floating    | Support 2 antennas |
| Low Level        | Support 4 antennas |

### 3.11. COEX UART Interface\*

EM120R-GL&EM160R-GL provide one COEX UART interface. The following table shows the COEX UART interface pin definition.

**Table 22: Pin Definition of COEX UART Interface**

| Pin Name | Pin No. | I/O | Description         | Comment            |
|----------|---------|-----|---------------------|--------------------|
| COEX3    | 60      | IO  | GPIO                | 1.8 V power domain |
| COEX_RXD | 62      | IO  | COEX UART Interface | 1.8 V power domain |
| COEX_TXD | 64      | IO  |                     | 1.8 V power domain |

#### NOTE

“\*” means under development.

### 3.12. Antenna Tuner Control Interfaces\*

ANTCTL [0:3] and RFFE signals are used for antenna tuner control and should be routed to an appropriate antenna control circuit. More details about the interface will be added in a future version of the document.

#### 3.12.1. Antenna Tuner Control Interface through GPIOs

Table 23: Pin Definition of Antenna Tuner Control Interface through GPIOs

| Pin Name | Pin No. | I/O | Description           | Comment            |
|----------|---------|-----|-----------------------|--------------------|
| ANTCTL0  | 59      | DO  | Antenna tuner control | 1.8 V power domain |
| ANTCTL1  | 61      | DO  | Antenna tuner control | 1.8 V power domain |
| ANTCTL2  | 63      | DO  | Antenna tuner control | 1.8 V power domain |
| ANTCTL3  | 65      | DO  | Antenna tuner control | 1.8 V power domain |

#### 3.12.2. Antenna Tuner Control Interface through RFFE

Table 24: Pin Definition of Antenna Tuner Control Interface through RFFE

| Pin Name  | Pin No. | I/O | Description                                           | Comment                  |
|-----------|---------|-----|-------------------------------------------------------|--------------------------|
| RFFE_CLK  | 56      | DO  | RFFE serial interface used for external tuner control | If unused, keep it open. |
| RFFE_DATA | 58      | IO  |                                                       | If unused, keep it open. |

#### NOTE

“\*\*” means under development.

### 3.13. Configuration Pins

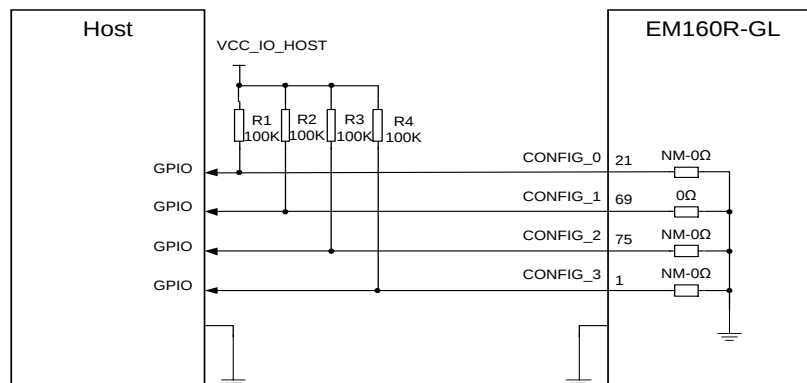
EM120R-GL&EM160R-GL provide four configuration pins which are defined as below.

#### 3.13.1. EM160R-GL configuration pins

Table 25: List of EM160R-GL Configuration Pins

| Pin No. | Pin Name | Power Domain | Description                  |
|---------|----------|--------------|------------------------------|
| 21      | CONFIG_0 | 0            | NC                           |
| 69      | CONFIG_1 | 0            | Connected to GND internally. |
| 75      | CONFIG_2 | 0            | NC                           |
| 1       | CONFIG_3 | 0            | NC                           |

The following figure shows a reference circuit of these four pins.



**Note:** The voltage level VCC\_IO\_HOST depends on the host side, and could be a 1.8 V or 3.3 V voltage level.

Figure 30: Recommended Circuit of EM160R-GL Configuration Pins

Table 26: List of EM160R-GL Configuration Pins

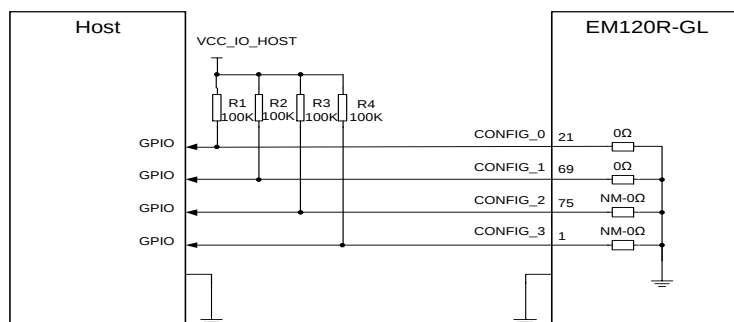
| Config_0<br>(Pin 21) | Config_1<br>(Pin 69) | Config_2<br>(Pin 75) | Config_3<br>(Pin 1) | Module Type and<br>Main Host Interface | Port<br>Configuration |
|----------------------|----------------------|----------------------|---------------------|----------------------------------------|-----------------------|
| NC                   | GND                  | NC                   | NC                  | Vender defined                         | N/A                   |

### 3.13.2. EM120R-GL configuration pins

Table 27: List of EM120R-GL Configuration Pins

| Pin No. | Pin Name | Power Domain | Description                  |
|---------|----------|--------------|------------------------------|
| 21      | CONFIG_0 | 0            | Connected to GND internally. |
| 69      | CONFIG_1 | 0            | Connected to GND internally. |
| 75      | CONFIG_2 | 0            | NC                           |
| 1       | CONFIG_3 | 0            | NC                           |

The following figure shows a reference circuit of these four pins.



**Note:** The voltage level VCC\_IO\_HOST depends on the host side, and could be a 1.8 V or 3.3 V voltage level.

Figure 31: Recommended Circuit of EM120R-GL Configuration Pins

Table 28: List of EM120R-GL Configuration Pins

| Config_0<br>(Pin 21) | Config_1<br>(Pin 69) | Config_2<br>(Pin 75) | Config_3<br>(Pin 1) | Module Type and<br>Main Host Interface | Port<br>Configuration |
|----------------------|----------------------|----------------------|---------------------|----------------------------------------|-----------------------|
| GND                  | GND                  | NC                   | NC                  | Vender defined                         | N/A                   |

# 4 GNSS Receiver

## 4.1. General Description

EM120R-GL&EM160R-GL include a fully integrated global navigation satellite system solution that supports Gen9-Lite of Qualcomm (GPS, GLONASS, BeiDou/Compass and Galileo).

The modules support standard NMEA-0183 protocol, and output NMEA sentences at 1 Hz data update rate via USB interface by default.

By default, EM120R-GL&EM160R-GL GNSS engine is switched off. It can only be switched on via AT command. For more details about GNSS engine technology and configurations, refer to **document [4]**.

## 5 Antenna Connection

EM120R-GL and EM160R-GL provide Main, Rx-diversity/GNSS and MIMO antenna connectors<sup>1)</sup> which are used to resist the fall of signals caused by high speed movement and multipath effect. The impedance of antenna ports is 50  $\Omega$ .

EM160R-GL provides a Main, an Rx-diversity/GNSS and two MIMO antenna connectors.

EM120R-GL provides a Main and an Rx-diversity/GNSS antenna connectors.

### 5.1. Antenna Connectors

The antenna connectors are shown below.

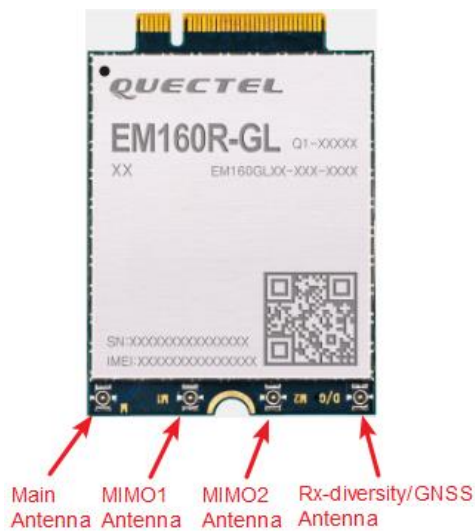


Figure 32: Antenna Connectors on the EM160R-GL Module



Figure 33: Antenna Connectors on the EM120R-GL Module

### 5.1.1. Operating Frequency

Table 29: Operating Frequencies of EM120R-GL&EM160R-GL

| 3GPP Band | Transmit  | Receive   | Unit |
|-----------|-----------|-----------|------|
| WCDMA B1  | 1920–1980 | 2110–2170 | MHz  |
| WCDMA B2  | 1850–1910 | 1930–1990 | MHz  |
| WCDMA B3  | 1710–1785 | 1805–1880 | MHz  |
| WCDMA B4  | 1710–1755 | 2110–2155 | MHz  |
| WCDMA B5  | 824–849   | 869–894   | MHz  |
| WCDMA B6  | 830–840   | 875–885   | MHz  |
| WCDMA B8  | 880–915   | 925–960   | MHz  |
| WCDMA B19 | 830–845   | 875–890   | MHz  |

|                       |           |           |     |
|-----------------------|-----------|-----------|-----|
| LTE B1                | 1920–1980 | 2110–2170 | MHz |
| LTE B2                | 1850–1910 | 1930–1990 | MHz |
| LTE B3                | 1710–1785 | 1805–1880 | MHz |
| LTE B4                | 1710–1755 | 2110–2155 | MHz |
| LTE B5                | 824–849   | 869–894   | MHz |
| LTE B7                | 2500–2570 | 2620–2690 | MHz |
| LTE B8                | 880–915   | 925–960   | MHz |
| LTE B12               | 699–716   | 729–746   | MHz |
| LTE B13               | 777–787   | 746–756   | MHz |
| LTE B14               | 788–798   | 758–768   | MHz |
| LTE B17               | 704–716   | 734–746   | MHz |
| LTE B18               | 815–830   | 860–875   | MHz |
| LTE B19               | 830–845   | 875–890   | MHz |
| LTE B20               | 832–862   | 791–821   | MHz |
| LTE B25               | 1850–1915 | 1930–1995 | MHz |
| LTE B26               | 814–849   | 859–894   | MHz |
| LTE B28               | 703–748   | 758–803   | MHz |
| LTE B29 <sup>1)</sup> | -         | 717–728   | MHz |
| LTE B30               | 2305–2315 | 2350–2360 | MHz |
| LTE B32 <sup>1)</sup> | -         | 1452–1496 | MHz |
| LTE B38               | 2570–2620 | 2570–2620 | MHz |
| LTE B39               | 1880–1920 | 1880–1920 | MHz |
| LTE B40               | 2300–2400 | 2300–2400 | MHz |
| LTE B41               | 2496–2690 | 2496–2690 | MHz |
| LTE B42               | 3400–3600 | 3400–3600 | MHz |

|                       |           |           |     |
|-----------------------|-----------|-----------|-----|
| LTE B43               | 3600–3800 | 3600–3800 | MHz |
| LTE B46 <sup>1)</sup> | 5150–5925 | 5150–5925 | MHz |
| LTE B48               | 3550–3700 | 3550–3700 | MHz |
| LTE B66               | 1710–1780 | 2110–2200 | MHz |

**NOTE**

<sup>1)</sup> LTE-FDD B29/32 and LTE-TDD B46 support Rx only and are only for secondary component carrier.

## 5.2. GNSS Antenna Connector

The following table shows frequency specification of GNSS antenna connector.

**Table 30: GNSS Frequency**

| Type           | Frequency       | Unit |
|----------------|-----------------|------|
| GPS/Galileo    | 1575.42 ±1.023  | MHz  |
| GLONASS        | 1601.65 ±4.15   | MHz  |
| BeiDou/Compass | 1561.098 ±2.046 | MHz  |

## 5.3. Antenna Installation

### 5.3.1. Antenna Requirements

The following table shows the requirements on Main, Rx-diversity/GNSS and MIMO antennas.

**Table 31: Antenna Requirements of EM160R-GL**

| Type                    | Requirements                                                                                                                                                                                                                                                   | Supported Bands                                                                                                                                                                                                                                                |
|-------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Main Antenna<br>(Tx/Rx) | VSWR: $\leq 2$<br>Efficiency: $> 30\%$<br>Max Input Power: 50 W<br>Input Impedance: 50 $\Omega$<br>Cable Insertion Loss: $< 1$ dB<br>(699–960 MHz)<br>Cable Insertion Loss: $< 1.5$ dB<br>(1710–2200 MHz)<br>Cable Insertion Loss: $< 2$ dB<br>(2300–2690 MHz) | <b>LTE:</b><br>B1/B2/B3/B4/B5/B7/B8/B12/B13/<br>B14/B17/B18/B19/B20/B25/B26/<br>B28/B29/B30/B32/B38/B39/B40/<br>B41/B42/B43/B46/B48/B66<br><br><b>WCDMA:</b><br>B1/B2/B3/B4/B5/B6/B8/B19                                                                       |
|                         | VSWR: $\leq 2$<br>Efficiency: $> 30\%$<br>Max Input Power: 50 W<br>Input Impedance: 50 $\Omega$<br>Cable Insertion Loss: $< 1$ dB<br>(699–960 MHz)<br>Cable Insertion Loss: $< 1.5$ dB<br>(1559–2200 MHz)<br>Cable Insertion Loss: $< 2$ dB<br>(2300–2690 MHz) | <b>LTE:</b><br>B1/B2/B3/B4/B5/B7/B8/B12/B13/<br>B14/B17/B18/B19/B20/B25/B26/<br>B28/B29/B30/B32/B38/B39/B40/<br>B41/B42/B43/B46/B48/B66<br><br><b>WCDMA:</b><br>B1/B2/B3/B4/B5/B6/B8/B19<br><br><b>GNSS:</b><br>GPS;<br>GLONASS;<br>BeiDou/Compass;<br>Galileo |
| MIMO1 Antenna<br>(Rx)   | VSWR: $\leq 2$<br>Efficiency: $> 30\%$<br>Max Input Power: 50 W<br>Input Impedance: 50 $\Omega$<br>Cable Insertion Loss: $< 1$ dB<br>(699–960 MHz)<br>Cable Insertion Loss: $< 1.5$ dB<br>(1559–2200 MHz)                                                      | <b>LTE:</b><br>B1/B2/B3/B4/B7/B25/<br>B30/B32/B38/B39/B40/B41/B66                                                                                                                                                                                              |

|                      |                                                   |                                                                   |
|----------------------|---------------------------------------------------|-------------------------------------------------------------------|
| MIMO2Antenna<br>(Rx) | Cable Insertion Loss: < 2 dB<br>(2300–2690 MHz)   | <b>LTE:</b><br>B1/B2/B3/B4/B7/B25/<br>B30/B32/B38/B39/B40/B41/B66 |
|                      | VSWR: ≤ 2                                         |                                                                   |
|                      | Efficiency: > 30%                                 |                                                                   |
|                      | Max Input Power: 50 W                             |                                                                   |
|                      | Input Impedance: 50 Ω                             |                                                                   |
|                      | Cable Insertion Loss: < 1 dB<br>(699–960 MHz)     |                                                                   |
|                      | Cable Insertion Loss: < 1.5 dB<br>(1559–2200 MHz) |                                                                   |
|                      | Cable Insertion Loss: < 2 dB<br>(2300–2690 MHz)   |                                                                   |

Table 32: Antenna Requirements of EM120R-GL

| Type                          | Requirements                                      | Supported Bands                                                                                                                         |
|-------------------------------|---------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------|
| Main Antenna<br>(Tx/Rx)       | VSWR: ≤ 2                                         | <b>LTE:</b><br>B1/B2/B3/B4/B5/B7/B8/B12/B13/<br>B14/B17/B18/B19/B20/B25/B26/<br>B28/B29/B30/B32/B38/B39/B40/<br>B41/B42/B43/B46/B48/B66 |
|                               | Efficiency: > 30%                                 |                                                                                                                                         |
|                               | Max Input Power: 50 W                             |                                                                                                                                         |
|                               | Input Impedance: 50 Ω                             |                                                                                                                                         |
|                               | Cable Insertion Loss: < 1 dB<br>(699–960 MHz)     |                                                                                                                                         |
|                               | Cable Insertion Loss: < 1.5 dB<br>(1710–2200 MHz) |                                                                                                                                         |
| Rx-diversity/<br>GNSS Antenna | Cable Insertion Loss: < 2dB<br>(2300–2690 MHz)    | <b>WCDMA:</b><br>B1/B2/B3/B4/B5/B6/B8/B19                                                                                               |
|                               | VSWR: ≤ 2                                         | <b>LTE:</b><br>B1/B2/B3/B4/B5/B7/B8/B12/B13/<br>B14/B17/B18/B19/B20/B25/B26/<br>B28/B29/B30/B32/B38/B39/B40/<br>B41/B42/B43/B46/B48/B66 |
|                               | Efficiency: > 30%                                 |                                                                                                                                         |
|                               | Max Input Power: 50 W                             |                                                                                                                                         |
|                               | Input Impedance: 50 Ω                             |                                                                                                                                         |
|                               | Cable Insertion Loss: < 1 dB<br>(699–960 MHz)     | <b>WCDMA:</b><br>B1/B2/B3/B4/B5/B6/B8/B19                                                                                               |
|                               | Cable Insertion Loss: < 1.5 dB<br>(1559–2200 MHz) |                                                                                                                                         |
|                               | Cable Insertion Loss: < 2 dB<br>(2300–2690 MHz)   |                                                                                                                                         |
|                               |                                                   | <b>GNSS:</b><br>GPS;<br>GLONASS;<br>BeiDou/Compass;<br>Galileo                                                                          |
|                               |                                                   |                                                                                                                                         |
|                               |                                                   |                                                                                                                                         |

### 5.3.2. Recommended RF Connector for Antenna Installation

EM120R-GL and EM160R-GL are mounted with standard 2 mm × 2 mm receptacle RF connectors for convenient antenna connection. The connector dimensions are illustrated below:

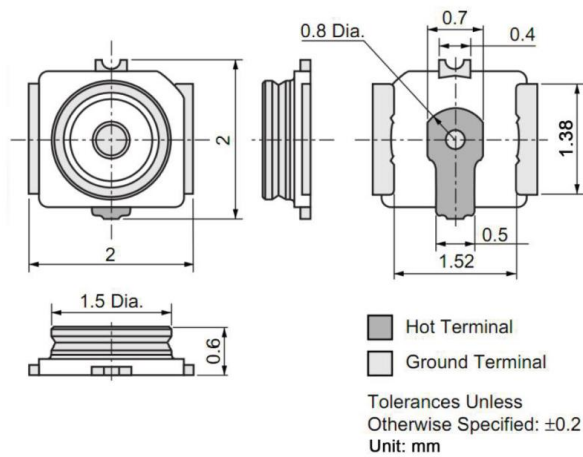


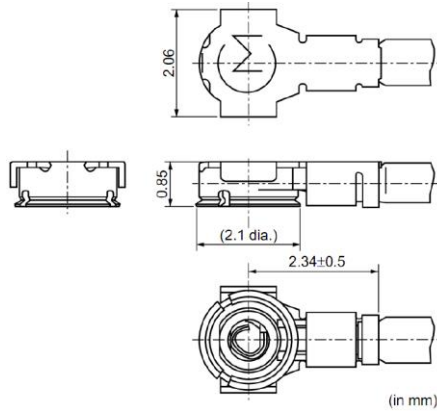
Figure 34: EM120R-GL&EM160R-GL RF Connector Dimensions (Unit: mm)

Table 33: Major Specifications of the RF Connector

| Item                               | Specification                                                           |
|------------------------------------|-------------------------------------------------------------------------|
| Nominal Frequency Range            | DC to 6 GHz                                                             |
| Nominal Impedance                  | 50 $\Omega$                                                             |
| Temperature Rating                 | -40 °C to +85 °C                                                        |
| Voltage Standing Wave Ratio (VSWR) | Meet the requirements of:<br>Max. 1.3 (DC–3 GHz)<br>Max. 1.45 (3–6 GHz) |

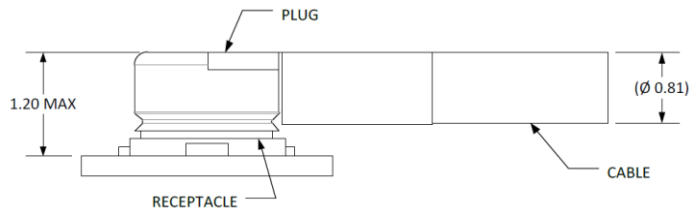
The receptacle RF connector used in conjunction with EM120R-GL&EM160R-GL will accept two types of mating plugs that will meet a maximum height of 1.2 mm using a  $\varnothing 0.81$  mm coaxial cable or a maximum height of 1.4 mm utilizing a  $\varnothing 1.13$  mm coaxial cable.

The following figure shows the specifications of mating plugs using  $\varnothing 0.81$  mm coaxial cables.



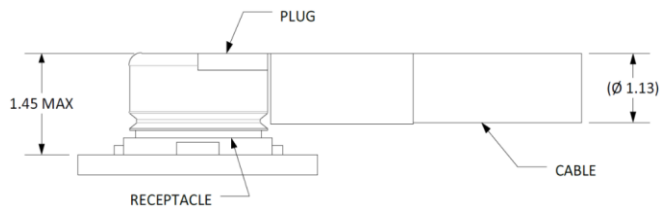
**Figure 35: Specifications of Mating Plugs Using  $\varnothing 0.81$  mm Coaxial Cables**

The following figure illustrates the connection between the receptacle RF connector on EM120R-GL&EM160R-GL and the mating plug using a  $\varnothing 0.81$  mm coaxial cable.



**Figure 36: Connection between RF Connector and Mating Plug Using  $\varnothing 0.81$  mm Coaxial Cable**

The following figure illustrates the connection between the receptacle RF connector on EM120R-GL&EM160R-GL and the mating plug using a  $\varnothing 1.13$  mm coaxial cable.



**Figure 37: Connection between RF Connector and Mating Plug Using  $\varnothing 1.13$  mm Coaxial Cable**

## 6 Electrical, Reliability and Radio Characteristics

### 6.1. Absolute Maximum Ratings

Absolute maximum ratings for power supply and voltage on digital and analog pins of the modules are listed in the following table.

Table 34: Absolute Maximum Ratings

| Parameter               | Min. | Max. | Unit |
|-------------------------|------|------|------|
| VCC                     | -0.3 | 4.7  | V    |
| Voltage at Digital Pins | -0.3 | 2.3  | V    |

### 6.2. Power Supply Requirements

The typical input voltage of EM120R-GL&EM160R-GL is 3.7 V, as specified by *PCIe M.2 Electromechanical Spec Rev1.0*. The following table shows the power supply requirements of the modules.

Table 35: Power Supply Requirements

| Parameter | Description  | Min.  | Typ. | Max. | Unit |
|-----------|--------------|-------|------|------|------|
| VCC       | Power Supply | 3.135 | 3.7  | 4.4  | V    |

### 6.3. I/O Requirements

Table 36: I/O Requirements

| Parameter       | Description         | Min.                       | Max.                  | Unit |
|-----------------|---------------------|----------------------------|-----------------------|------|
| V <sub>IH</sub> | Input high voltage  | $0.7 \times V_{DD18}^{1)}$ | $V_{DD18} + 0.3$      | V    |
| V <sub>IL</sub> | Input low voltage   | -0.3                       | $0.3 \times V_{DD18}$ | V    |
| V <sub>OH</sub> | Output high voltage | $V_{DD18} - 0.5$           | $V_{DD18}$            | V    |
| V <sub>OL</sub> | Output low voltage  | 0                          | 0.4                   | V    |

#### NOTE

<sup>1)</sup> V<sub>DD18</sub> refers to I/O power domain.

### 6.4. Operation and Storage Temperatures

Table 37: Operation and Storage Temperatures

| Parameter                                 | Min. | Typ. | Max. | Unit |
|-------------------------------------------|------|------|------|------|
| Operating temperature Range <sup>1)</sup> | -25  | +25  | +75  | °C   |
| Extended Temperature Range <sup>2)</sup>  | -40  |      | +85  | °C   |
| Storage temperature Range                 | -40  |      | +90  | °C   |

#### NOTES

- <sup>1)</sup> Within operating temperature range, the module is 3GPP compliant. For those end devices with bad thermal dissipation condition, a thermal pad or other thermal conductive components may be required between the module and main PCB to achieve the full operating temperature range.
- <sup>2)</sup> Within extended temperature range, the module remains the ability to establish and maintain a voice, SMS, data transmission, emergency call, etc. There is no unrecoverable malfunction. There are also no effects on radio spectrum and no harm to radio network. Only one or more parameters like

$P_{out}$  might reduce in their values and exceed the specified tolerances. When the temperature returns to the normal operating temperature level, the module will meet 3GPP specifications again.

## 6.5. Current Consumption

Table 38: EM120R-GL&EM160R-GL Current Consumption

| Parameter | Description | Conditions | Typ. | Unit |
|-----------|-------------|------------|------|------|
| Ivcc      | OFF state   | Power down | TBD  | μA   |

## 6.6. RF Output Power

The following table shows the RF output power of EM120R-GL&EM160R-GL.

Table 39: RF Output Power

| Frequency                                           | (Quectel SPEC)<br>Max. | Min.      |
|-----------------------------------------------------|------------------------|-----------|
| WCDMA band <a href="#">1, 3, 5, 8s</a>              | 24 dBm +1.5/-3 dB      | < -50 dBm |
| LTE-FDD band <a href="#">1, 3, 5, 7, 8, 20, 28s</a> | 23 dBm ±2 dB           | < -40 dBm |
| LTE-TDD band <a href="#">38, 40, 41, 42, 43s</a>    | 23 dBm ±2 dB           | < -40 dBm |

设置了格式

设置了格式：字体：五号

设置了格式：字体：五号

设置了格式：字体：五号

## 6.7. RF Receiving Sensitivity

The following tables show conducted RF min. receiving sensitivity of EM120R-GL and EM160R-GL.

**Table 40: EM120R-GL&EM160R-GL Conducted RF Min. Receiving Sensitivity**

| Frequency            | Primary | Diversity | SIMO <sup>1)</sup> | SIMO <sup>2)</sup> (Worst Case) |
|----------------------|---------|-----------|--------------------|---------------------------------|
| WCDMA B1             | -111    | -110      | -110.5             | -106.7 dBm                      |
| WCDMA B2             | -109.5  | -110      | -110               | -104.7 dBm                      |
| WCDMA B3             | -109.5  | -110.5    | -111               | -103.7 dBm                      |
| WCDMA B4             | TBD     | TBD       | TBD                | -106.7 dBm                      |
| WCDMA B5             | -111    | -111      | -112               | -104.7 dBm                      |
| WCDMA B6             | TBD     | TBD       | TBD                | -106.7 dBm                      |
| WCDMA B8             | -111.5  | -110.5    | -111               | -103.7 dBm                      |
| WCDMA B19            | TBD     | TBD       | TBD                | -106.7 dBm                      |
| LTE-FDD B1 (10 MHz)  | -98     | -98       | -100.7             | -96.3 dBm                       |
| LTE-FDD B2 (10 MHz)  | -97.8   | -97.7     | -100.3             | -94.3 dBm                       |
| LTE-FDD B3 (10 MHz)  | -98.8   | -97.3     | -100.8             | -93.3 dBm                       |
| LTE-FDD B4 (10 MHz)  | -97.7   | -97.9     | -100.6             | -96.3 dBm                       |
| LTE-FDD B5 (10 MHz)  | -99.7   | -99       | -102               | -94.3 dBm                       |
| LTE-FDD B7 (10 MHz)  | -96     | -97.2     | -99.4              | -94.3 dBm                       |
| LTE-FDD B8 (10 MHz)  | -99     | -99.2     | -101.7             | -93.3 dBm                       |
| LTE-FDD B12 (10 MHz) | -99.8   | -99.5     | -102.3             | -93.3 dBm                       |
| LTE-FDD B13 (10 MHz) | -100.2  | -99.4     | -102.5             | -93.3 dBm                       |
| LTE-FDD B14 (10 MHz) | -99.2   | -99.2     | -101.8             | -93.3 dBm                       |
| LTE-FDD B17 (10 MHz) | -99.9   | -99.6     | -102.3             | -93.3 dBm                       |
| LTE-FDD B18 (10 MHz) | -99.6   | -99.4     | -102.2             | -96.3 dBm                       |

|                      |       |       |        |           |
|----------------------|-------|-------|--------|-----------|
| LTE-FDD B19 (10 MHz) | -99.7 | -99   | -102   | -96.3 dBm |
| LTE-FDD B20 (10 MHz) | -99.7 | -99.5 | -102.2 | -93.3 dBm |
| LTE-FDD B25 (10 MHz) | -97.8 | -97.6 | -100.3 | -92.8 dBm |
| LTE-FDD B26 (10 MHz) | -99.4 | -99.1 | -101.9 | -93.8 dBm |
| LTE-FDD B28 (10 MHz) | -99.3 | -99.6 | -102.1 | -94.8 dBm |
| LTE-FDD B30 (10 MHz) | -96   | -97.4 | -99.5  | -95.3 dBm |
| LTE-TDD B38 (10 MHz) | -98.4 | -97   | -100.1 | -96.3 dBm |
| LTE-FDD B39 (10 MHz) | -98.4 | -97.5 | -100.5 | -96.3 dBm |
| LTE-TDD B40 (10 MHz) | -96.3 | -96.9 | -99.2  | -96.3 dBm |
| LTE-TDD B41 (10 MHz) | -98.1 | -96.1 | -99.7  | -94.3 dBm |
| LTE-TDD B42 (10 MHz) | -97.3 | -98.7 | -100.7 | -95.0 dBm |
| LTE-TDD B43 (10 MHz) | -97.4 | -98.4 | -100.7 | -95.0 dBm |
| LTE-TDD B48 (10 MHz) | -97.3 | -98.5 | -100.6 | -95.0 dBm |
| LTE-FDD B66 (10 MHz) | -97.6 | -97.8 | -100.4 | -95.8 dBm |

#### NOTES

- <sup>1)</sup> SIMO is a smart antenna technology that uses a single antenna at the transmitter side and multiple antennas at the receiver side, which can improve Rx performance.
- <sup>2)</sup> Per 3GPP specification.

## 6.8. Characteristics

The modules are not protected against electrostatic discharge (ESD) in general. Consequently, it is subject to ESD handling precautions that typically apply to ESD sensitive components. Proper ESD handling and packaging procedures must be applied throughout the processing, handling and operation of any application that incorporates the modules.

The following table shows the modules' electrostatic discharge characteristics.

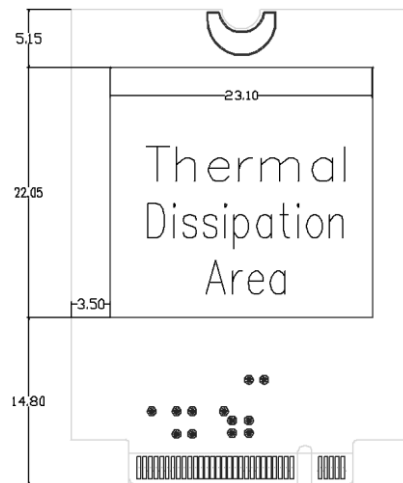
**Table 41: Electrostatic Discharge Characteristics (Temperature: 25 °C, Humidity: 40%)**

| Interfaces         | Contact Discharge | Air Discharge | Unit |
|--------------------|-------------------|---------------|------|
| VCC, GND           | TBD               | TBD           | kV   |
| Antenna Interfaces | TBD               | TBD           | kV   |
| Other Interfaces   | TBD               | TBD           | kV   |

## 6.9. Thermal Dissipation

EM120R-GL&EM160R-GL are designed to work over an extended temperature range. In order to achieve a better performance while working under extended temperatures or extreme conditions (such as with maximum power or data rate, etc.) for a long time, it is strongly recommended to add a thermal pad or other thermally conductive compounds between the module and the main PCB for thermal dissipation.

The thermal dissipation area (i.e. the area for adding thermal pad) is shown as below. The dimensions are measured in mm.



**Figure 38: Thermal Dissipation Area on Bottom Side of Module (Top View)**

There are some other measures to enhance heat dissipation performance:

- Add ground vias as many as possible on PCB.
- Maximize airflow over/around the module.
- Place the module away from other heating sources.
- Module mounting holes must be used to attach (ground) the device to the main PCB ground.
- It is NOT recommended to apply solder mask on the main PCB where the module's thermal dissipation area is located.
- Select an appropriate material, thickness and surface for the outer housing (i.e. the mechanical enclosure) of the application device that integrates the module so that it provides good thermal dissipation.
- Customers may also need active cooling to pull heat away from the module.
- If possible, add a heatsink on the top of the module. A thermal pad should be used between the heatsink and the module, and the heatsink should be designed with as many fins as possible to increase heat dissipation area.

**NOTE**

For more detailed guidelines on thermal design, refer to **document [5]**.

## 7 Mechanical Dimensions and Packaging

This chapter mainly describes mechanical dimensions and packaging specifications of EM120R-GL&EM160R-GL. All dimensions are measured in mm, and the dimensional tolerances are  $\pm 0.05$  mm unless otherwise specified.

### 7.1. Mechanical Dimensions of the Module

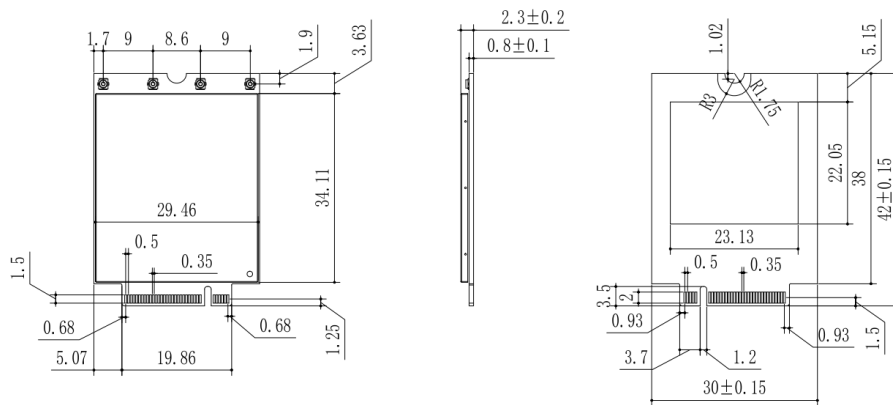


Figure 39: Mechanical Dimensions of EM120R-GL&EM160R-GL (Unit: mm)

## 7.2. Standard Dimensions of M.2 PCI Express

The following figure shows the standard dimensions of M.2 PCI Express, refer to [document \[6\]](#).

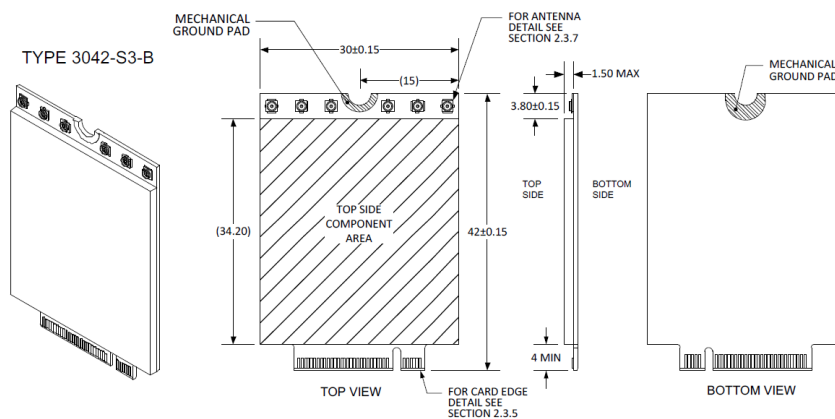


Figure 40: Standard Dimensions of M.2 Type 3042-S3 (Unit: mm)

According to M.2 nomenclature, EM120R-GL&EM160R-GL are Type 3042-S3-B (30.0 mm × 42.0 mm, max component height on the top is 1.5 mm and single-sided, key ID is B).

Type XX - XX - X - X<sup>o</sup>

| Width (mm) | Length (mm) | Label** | Component Max Ht (mm) |            | Key ID | Pin   | Interface                                           |
|------------|-------------|---------|-----------------------|------------|--------|-------|-----------------------------------------------------|
|            |             |         | Top Max               | Bottom Max |        |       |                                                     |
| 12         | 16          | S1      | 1.2                   | 0****      | A      | 8-15  | 2x PCIe x1 / USB 2.0 / I2C / DP x4                  |
| 16         | 26          | S2      | 1.35                  | 0****      | B      | 12-19 | PCIe x2/SATA/USB 2.0/USB 3.0/HSC/SSIC/Audio/UIM/I2C |
| 22         | 30          | S3      | 1.5                   | 0****      | C      | 16-23 | Reserved for Future Use                             |
| 30         | 42          | D1      | 1.2                   | 1.35       | D      | 20-27 | Reserved for Future Use                             |
|            | 60          | D2      | 1.35                  | 1.35       | E      | 24-31 | 2x PCIe x1 / USB 2.0 / I2C / SDIO / UART / PCM      |
|            | 80          | D3      | 1.5                   | 1.35       | F      | 28-35 | Future Memory Interface (FMI)                       |
|            | 110         | D4      | 1.5                   | 0.7        | G      | 39-46 | Generic (Not used for M.2)***                       |
|            |             | D5      | 1.5                   | 1.5        | H      | 43-50 | Reserved for Future Use                             |
|            |             |         |                       |            | J      | 47-54 | Reserved for Future Use                             |
|            |             |         |                       |            | K      | 51-58 | Reserved for Future Use                             |
|            |             |         |                       |            | L      | 55-62 | Reserved for Future Use                             |
|            |             |         |                       |            | M      | 59-66 | PCIe x4 / SATA                                      |

- \* Use ONLY when a double slot is being specified
- \*\* Label included in height dimension
- \*\*\* Key G is intended for custom use. Devices with this key will not be M.2-compliant. Use at your own risk!
- \*\*\*\* Insulating label allowed on connector-based designs

Figure 41: M.2 Nomenclature

### 7.3. Design Effect Drawings of the Module

#### 7.3.1. Design Effect Drawings of EM160R-GL Module



Figure 42: Top View of the Module



Figure 43: Bottom View of the Module

### 7.3.2. Design Renderings of EM120R-GL Module



Figure 44: Top View of the Module



Figure 45: Bottom View of the Module

#### NOTE

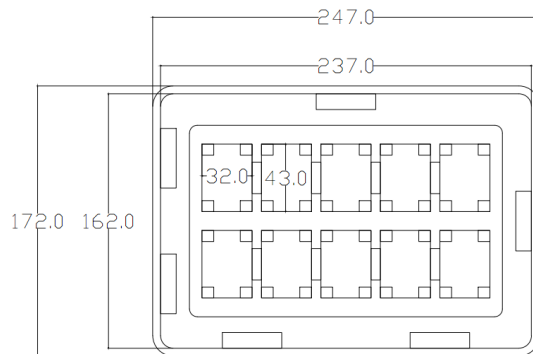
These are renderings of EM120R-GL&EM160R-GL. For authentic appearance, refer to the modules that you receive from Quectel.

## 7.4. M.2 Connector

EM120R-GL&EM160R-GL adopt a standard PCI Express M.2 connector which compiles with the directives and standards listed in the **document [6]**.

## 7.5. Packaging

EM120R-GL&EM160R-GL are packaged in trays. The following figure shows the tray size.



**Figure 46: Tray Size (Unit: mm)**

Each tray contains 10 modules. The smallest package contains 100 modules. Tray packaging procedures are as below.

1. Use 10 trays to package 100 modules at a time (tray size: 247 mm × 172 mm).
2. Place an empty tray on the top of the 10-tray stack.
3. Fix the stack with masking tape in "H" shape as shown in the following figure.
4. Pack the stack with conductive bag, and then fix the bag with masking tape.
5. Place the list of IMEI No. into a small carton.
6. Seal the carton and then label the seal with sealing sticker (small carton size: 250 mm × 175 mm × 128 mm).



Figure 47: Tray Packaging Procedure

## 8 Appendix References

**Table 42: Related Documents**

| SN  | Document Name                                       | Remark                                      |
|-----|-----------------------------------------------------|---------------------------------------------|
| [1] | Quectel_EM120R-GL&EM160R-GL_CA_Feature              | EM120R-GL&EM160R-GL CA Feature              |
| [2] | Quectel_M.2_EVB_User_Guide                          | M.2 EVB User Guide                          |
| [3] | Quectel_EM120R-GL&EM160R-GL_AT_Commands_Manual      | EM120R-GL&EM160R-GLAT Commands Manual       |
| [4] | Quectel_EM120R-GL&EM160R-GL_GNSS_AT_Commands_Manual | EM120R-GL&EM160R-GL GNSS AT Commands Manual |
| [5] | Quectel_LTE_Module_Thermal_Design_Guide             | Thermal Design Guide for LTE Modules        |
| [6] | PCI Express M.2 Specification                       |                                             |

**Table 43: Terms and Abbreviations**

| Abbreviation | Description                                                                                      |
|--------------|--------------------------------------------------------------------------------------------------|
| bps          | Bits Per Second                                                                                  |
| DC-HSPA+     | Dual-carrier High Speed Packet Access                                                            |
| DFOTA        | Delta Firmware Upgrade Over The Air                                                              |
| DL           | Downlink                                                                                         |
| DRx          | Diversity Receive                                                                                |
| ESD          | Electrostatic Discharge                                                                          |
| FDD          | Frequency Division Duplexing                                                                     |
| GLONASS      | Globalnaya Navigatsionnaya Sputnikovaya Sistema (the Russian Global Navigation Satellite System) |
| GNSS         | Global Navigation Satellite System                                                               |

|       |                                               |
|-------|-----------------------------------------------|
| GPS   | Global Positioning System                     |
| GSM   | Global System for Mobile Communications       |
| HSPA  | High Speed Packet Access                      |
| HSUPA | High Speed Uplink Packet Access               |
| kbps  | Kilo Bits Per Second                          |
| LED   | Light Emitting Diode                          |
| LTE   | Long Term Evolution                           |
| Mbps  | Million Bits Per Second                       |
| ME    | Mobile Equipment (Module)                     |
| MIMO  | Multiple-Input Multiple-Output                |
| MLCC  | Multilayer Ceramic Chip Capacitor             |
| MMS   | Multimedia Messaging Service                  |
| MO    | Mobile Originated                             |
| MT    | Mobile Terminated                             |
| PDU   | Protocol Data Unit                            |
| PPP   | Point-to-Point Protocol                       |
| PRx   | Primary Receive                               |
| RF    | Radio Frequency                               |
| Rx    | Receive                                       |
| SAR   | Specific Absorption Rate                      |
| SMS   | Short Message Service                         |
| Tx    | Transmit                                      |
| UART  | Universal Asynchronous Receiver & Transmitter |
| UL    | Uplink                                        |
| URC   | Unsolicited Result Code                       |

|        |                                              |
|--------|----------------------------------------------|
| (U)SIM | (Universal) Subscriber Identification Module |
| WCDMA  | Wideband Code Division Multiple Access       |

## FCC KDB996369 D03v01 Requirements

### List of applicable FCC rules

FCC Part 15 Subpart B, Part 22 Subpart H, Part 24 Subpart E, Part 27 Subpart D & L & H & F & M & N, Part 90 Subpart R & S, Part 96

### Summarize the specific operational use conditions

Not Applicable

### Limited module procedures

Not Applicable

### Trace antenna designs

Refer to Manual Section 4

### RF exposure considerations

Refer to FCC certification requirements

### Antennas

| Technology         | Frequency Range (MHz) | Antenna Type | Max Peak Gain (dBi) |
|--------------------|-----------------------|--------------|---------------------|
| WCDMA & LTE Band 2 | 1850 ~ 1910           | Dipole       | 1.15                |
| WCDMA & LTE Band 4 | 1710 ~ 1755           |              | -0.50               |
| WCDMA & LTE Band 5 | 824 ~ 849             |              | 1.85                |
| LTE Band 7         | 2500 ~ 2570           |              | 1.32                |
| LTE Band 12        | 699 ~ 716             |              | -2.43               |
| LTE Band 13        | 777 ~ 787             |              | -0.10               |
| LTE Band 14        | 788 ~ 798             |              | 2.40                |
| LTE Band 25        | 1850 ~ 1915           |              | 1.15                |
| LTE Band 26        | 814 ~ 849             |              | 1.85                |
| LTE Band 30        | 2305 ~ 2315           |              | -3.64               |
| LTE Band 38        | 2570 ~ 2620           |              | 0.93                |
| LTE Band 41        | 2496 ~ 2690           |              | 0.93                |
| LTE Band 48        | 3550 ~ 3700           |              | -3.37               |
| LTE Band 66        | 1710 ~ 1780           |              | -0.50               |

### Label and compliance information

Refer to FCC Label

### Information on test modes and additional testing requirements

Not Applicable

**Additional testing, Part 15 Subpart B disclaimer**

Refer to FCC 15B Report

## **FCC Certification Requirements.**

According to the definition of mobile and fixed device is described in Part 2.1091(b), this device is a mobile device.

And the following conditions must be met:

1. This Modular Approval is limited to OEM installation for mobile and fixed applications only. The antenna installation and operating configurations of this transmitter, including any applicable source-based time-averaging duty factor, antenna gain and cable loss must satisfy MPE categorical Exclusion Requirements of 2.1091.
2. The EUT is a mobile device; maintain at least a 20 cm separation between the EUT and the user's body and must not transmit simultaneously with any other antenna or transmitter.
3. A label with the following statements must be attached to the host end product: This device contains FCC ID: XMR2020EM160RGL.
4. This module must not transmit simultaneously with any other antenna or transmitter
5. The host end product must include a user manual that clearly defines operating requirements and conditions that must be observed to ensure compliance with current FCC RF exposure guidelines.

For portable devices, in addition to the conditions 3 through 6 described above, a separate approval is required to satisfy the SAR requirements of FCC Part 2.1093

If the device is used for other equipment that separate approval is required for all other operating configurations, including portable configurations with respect to 2.1093 and different antenna configurations.

For this device, OEM integrators must be provided with labeling instructions of finished products. Please refer to KDB784748 D01 v07, section 8. Page 6/7 last two paragraphs:

A certified modular has the option to use a permanently affixed label, or an electronic label. For a permanently affixed label, the module must be labeled with an FCC ID - Section 2.926 (see 2.2 Certification (labeling requirements) above). The OEM manual must provide clear instructions explaining to the OEM the labeling requirements, options and OEM user manual instructions that are required (see next paragraph).

For a host using a certified modular with a standard fixed label, if (1) the module's FCC ID is not visible when installed in the host, or (2) if the host is marketed so that end users do not have straightforward commonly used methods for access to remove the module so that the FCC ID of the module is visible; then an additional permanent label referring to the enclosed module: "Contains Transmitter Module FCC ID: XMR2020EM160RGL" or "Contains FCC ID: XMR2020EM160RGL" must be used. The host OEM user manual must also contain clear instructions on how end users can find and/or access the module and the FCC ID.

The final host / module combination may also need to be evaluated against the FCC Part 15B criteria for unintentional radiators in order to be properly authorized for operation as a Part 15 digital device.

The user's manual or instruction manual for an intentional or unintentional radiator shall caution the user that changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment. In cases where the manual is provided only in a form other than paper, such as on a computer disk or over the Internet, the information required by this section may be included in the manual in that alternative form,

provided the user can reasonably be expected to have the capability to access information in that form.

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

(1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the manufacturer could void the user's authority to operate the equipment.

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/ TV technician for help.

## IC Statement

### IRSS-GEN

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

### Radiation Exposure Statement:

The EUT is a mobile device; maintain at least a 20 cm separation between the EUT and the user's body and must not transmit simultaneously with any other antenna or transmitter.

### Déclaration d'exposition aux radiations:

L'EST est un appareil mobile; maintenir une distance d'au moins 20 cm entre l'EST et le corps de l'utilisateur et ne pas émettre simultanément avec une autre antenne ou un autre émetteur.

### Antennas

| Technology         | Frequency Range (MHz) | Antenna Type | Max Peak Gain (dBi) |
|--------------------|-----------------------|--------------|---------------------|
| WCDMA & LTE Band 2 | 1850 ~ 1910           | Dipole       | 1.15                |
| WCDMA & LTE Band 4 | 1710 ~ 1755           |              | -0.50               |
| WCDMA & LTE Band 5 | 824 ~ 849             |              | 1.85                |
| LTE Band 7         | 2500 ~ 2570           |              | 1.32                |
| LTE Band 12        | 699 ~ 716             |              | -2.43               |
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| LTE Band 14        | 788 ~ 798             |              | 2.40                |
| LTE Band 25        | 1850 ~ 1915           |              | 1.15                |
| LTE Band 26        | 814 ~ 849             |              | -3.64               |
| LTE Band 30        | 2305 ~ 2315           |              | 0.93                |
| LTE Band 38        | 2570 ~ 2620           |              | 0.93                |
| LTE Band 41        | 2496 ~ 2690           |              | -0.50               |
| LTE Band 48        | 3550 ~ 3700           |              | -3.37               |
| LTE Band 66        | 1710 ~ 1780           |              | -0.50               |

## Antennes

| Technologie        | Gamme de fréquences (MHz) | Type d'antenne | Gain de crête maximum (dBi) |
|--------------------|---------------------------|----------------|-----------------------------|
| WCDMA & LTE Band 2 | 1850 ~ 1910               | Dipole         | 1.15                        |
| WCDMA & LTE Band 4 | 1710 ~ 1755               |                | -0.50                       |
| WCDMA & LTE Band 5 | 824 ~ 849                 |                | 1.85                        |
| LTE Bande 7        | 2500 ~ 2570               |                | 1.32                        |
| LTE Bande 12       | 699 ~ 716                 |                | -2.43                       |
| LTE Bande 13       | 777 ~ 787                 |                | -0.10                       |
| LTE Bande 14       | 788 ~ 798                 |                | 2.40                        |
| LTE Bande 25       | 1850 ~ 1915               |                | 1.15                        |
| LTE Bande 30       | 2305 ~ 2315               |                | -3.64                       |
| LTE Bande 38       | 2570 ~ 2620               |                | 0.93                        |
| LTE Bande 41       | 2500 ~ 2690               |                | 0.93                        |
| LTE Bande 66       | 1710 ~ 1780               |                | -0.50                       |

The host product shall be properly labelled to identify the modules within the host product. The Innovation, Science and Economic Development Canada certification label of a module shall be clearly visible at all times when installed in the host product; otherwise, the host product must be labeled to display the Innovation, Science and Economic Development Canada certification number for the module, preceded by the word "Contains" or similar wording expressing the same meaning, as follows: "Contains IC: 10224A-2020EM160GL" or "where: 10224A-2020EM160GL is the module's certification number".

Le produit hôte doit être correctement étiqueté pour identifier les modules dans le produit hôte. L'étiquette de certification d'Innovation, Sciences et Développement économique Canada d'un module doit être clairement visible en tout temps lorsqu'il est installé dans le produit hôte; sinon, le produit hôte doit être étiqueté pour afficher le numéro de certification d'Innovation, Sciences et Développement économique Canada pour le module, précédé du mot «Contient» ou d'un libellé similaire exprimant le même sens, comme suit: Contient IC: 10224A-2020EM160GL ou "où: 10224A-2020EM160GL est le numéro de certification du module".